

# HIGH EFFICIENCY CRYSTALLINE SILICON SOLAR CELLS



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for  
Solar Energy Systems ISE

Lecture KIT  
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# TODAY'S GOAL

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1. Which leverage can be used to increase efficiency of silicon solar cells ?
2. How do different types of high efficiency silicon solar cells work ?

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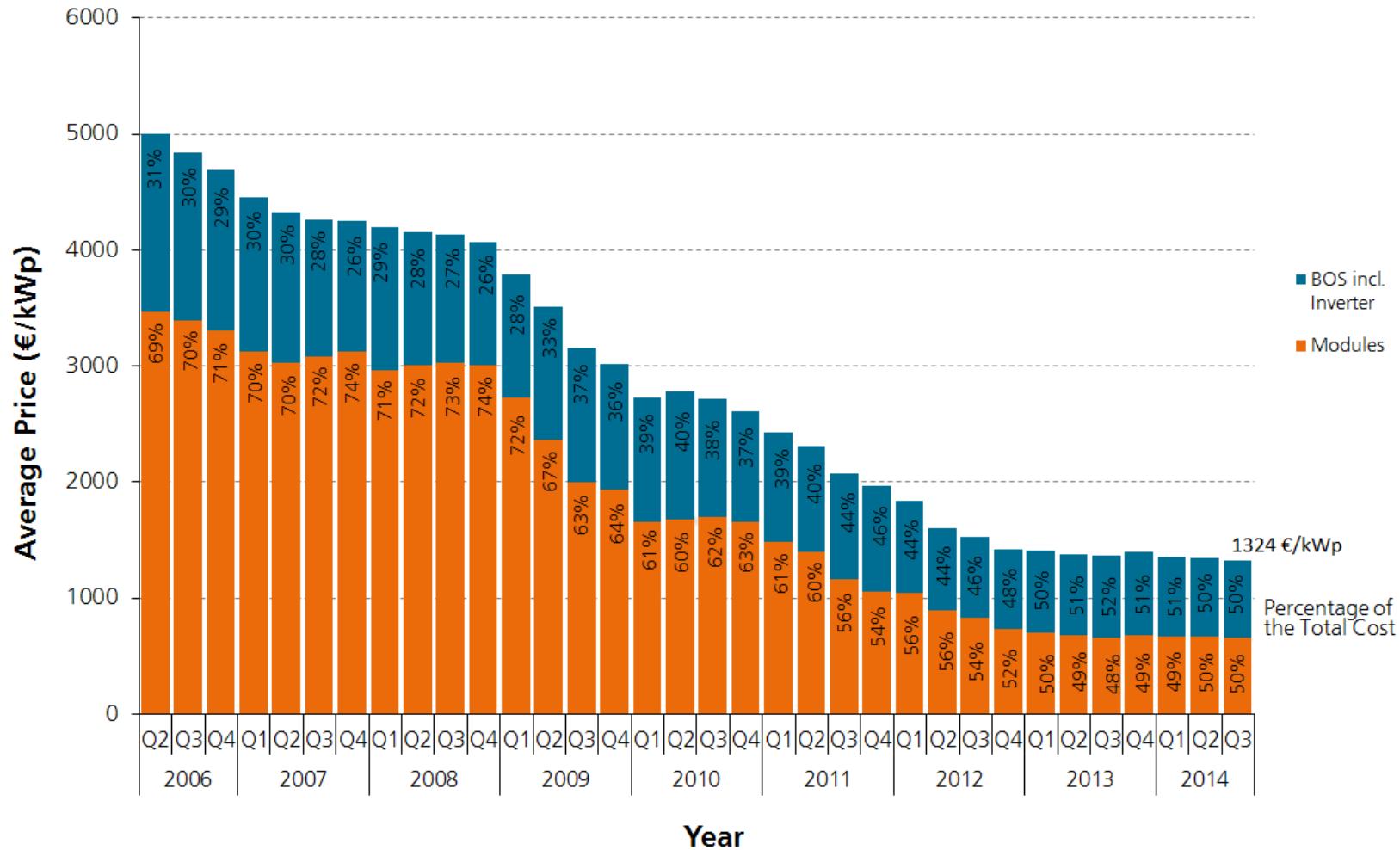
# AGENDA

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- Why high efficiencies?
- What is the efficiency limit for silicon solar cells?
- General strategy for high efficiencies
- Analyzing and fixing main losses in different solar cell types – the leaky bucket
- Future steps

# Dramatic Price Decrease

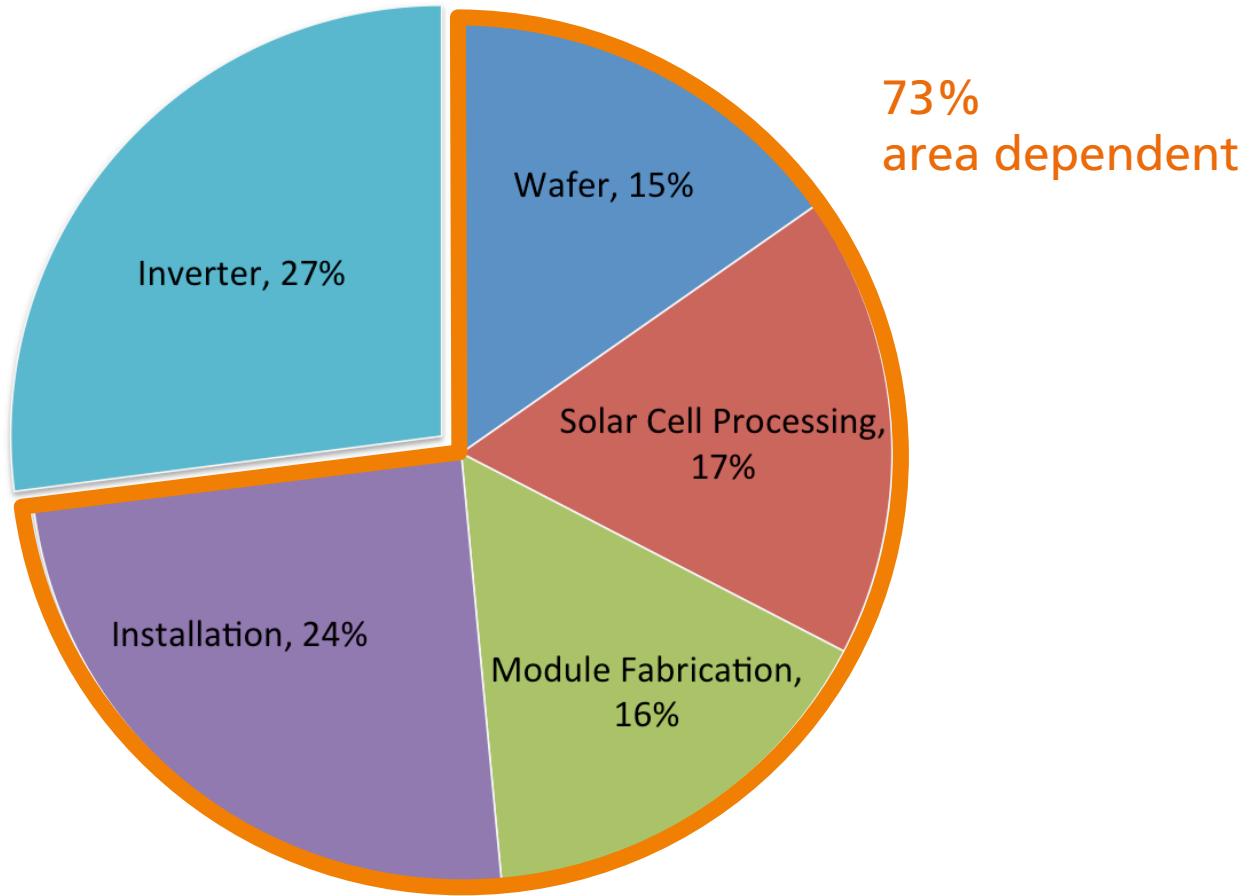
## Average Price for German Rooftop Systems



Data: BSW-Solar. Graph: PSE AG 2014

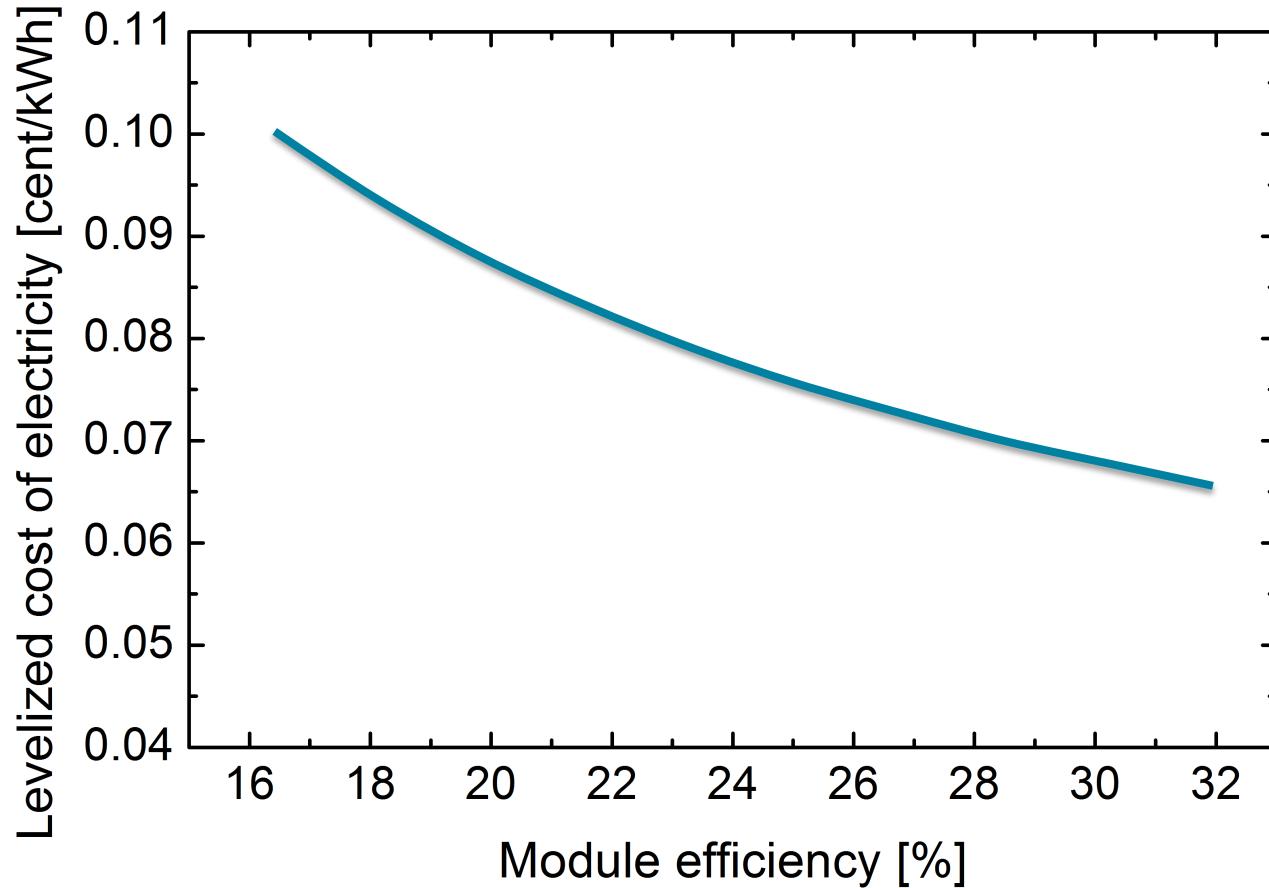
# High Efficiencies for Cost Reduction

## System Cost Structure



# High Efficiencies for Cost Reduction

## Levelized Cost of electricity



# Why High Efficiencies?

- Higher efficiencies can decrease the specific costs of photovoltaic systems, because more output is generated from the same amount of input (land, materials, labor etc. )

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# AGENDA

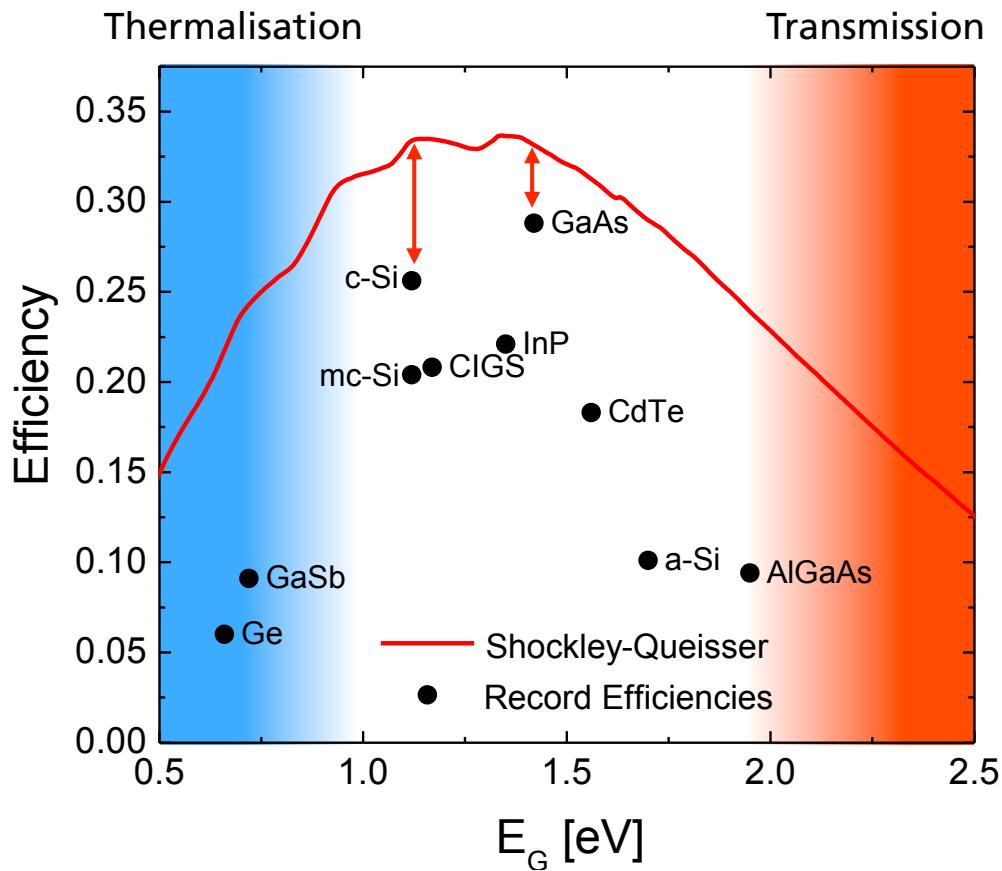
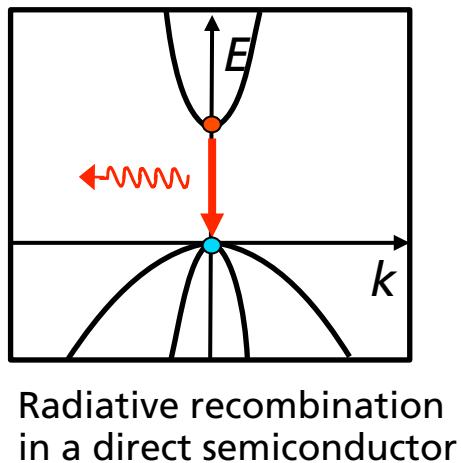
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- Why high efficiencies?
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# What is the limit?

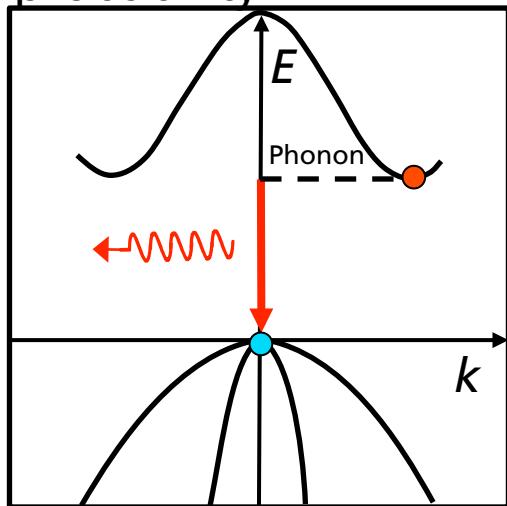
## Detailed Balance and Radiative Recombination

- Shockley und Queisser, 1961
- Detailed balance between sun and solar cell
- Assumption: Solar cell emits photons via radiative recombination



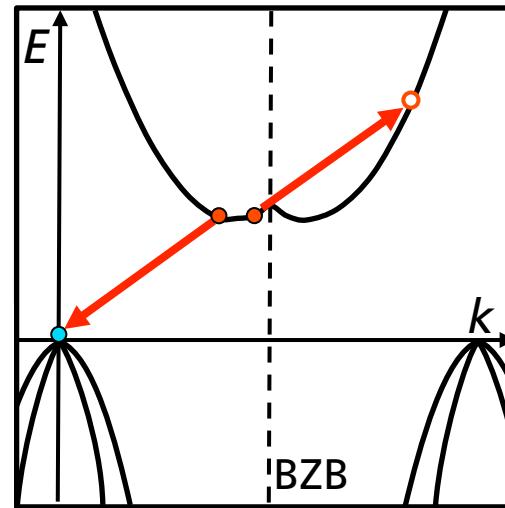
# What is the Limit? Reduced Radiative Recombination in Silicon

- Silicon is an indirect semiconductor  
→ radiative recombination has a low probability



Radiative recombination in an indirect semiconductor

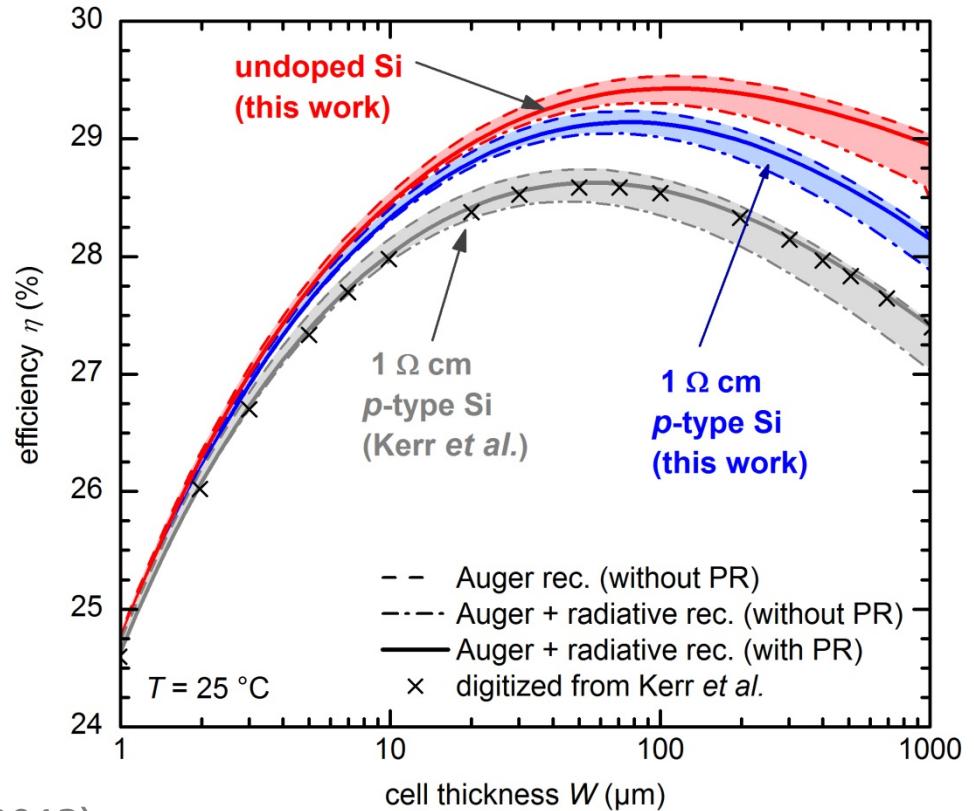
- In silicon solar cells Auger-recombination is the limiting intrinsic loss mechanism



Auger recombination in an indirect semiconductor

# What is the limit? Taking Auger Recombination into Account

- Shockley, Queisser (1961)  
= 33% (AM1.5)
- Theoretical efficiency limit  
for silicon (taking actual  
Auger model<sup>1</sup> into account)  
= 29.4%<sup>2</sup>



<sup>1</sup>Richter, Glunz et al., *Phys. Rev. B* 86 (2013)

<sup>2</sup>Richter, Hermle, Glunz, *IEEE J. Photovolt.* (2013)

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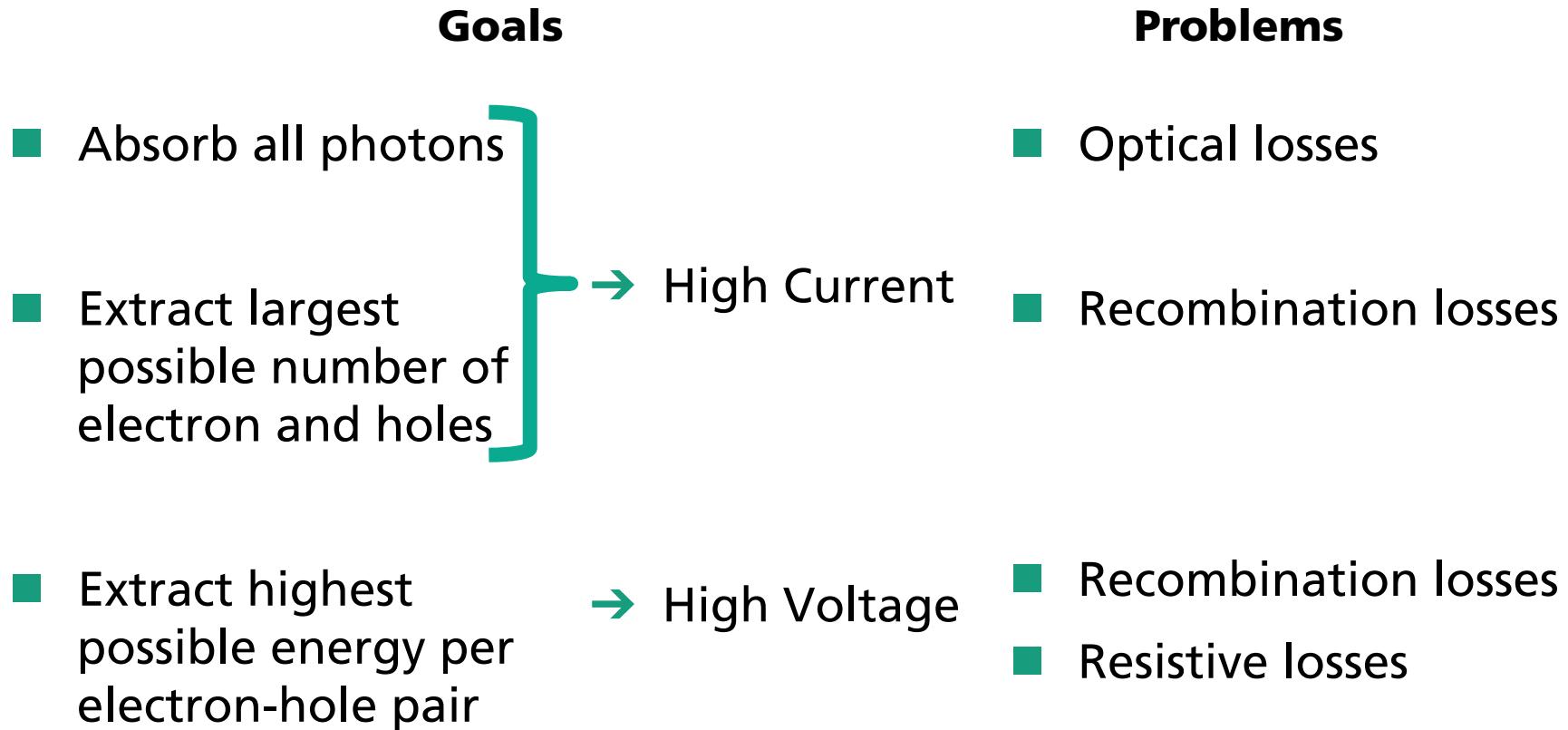
# AGENDA

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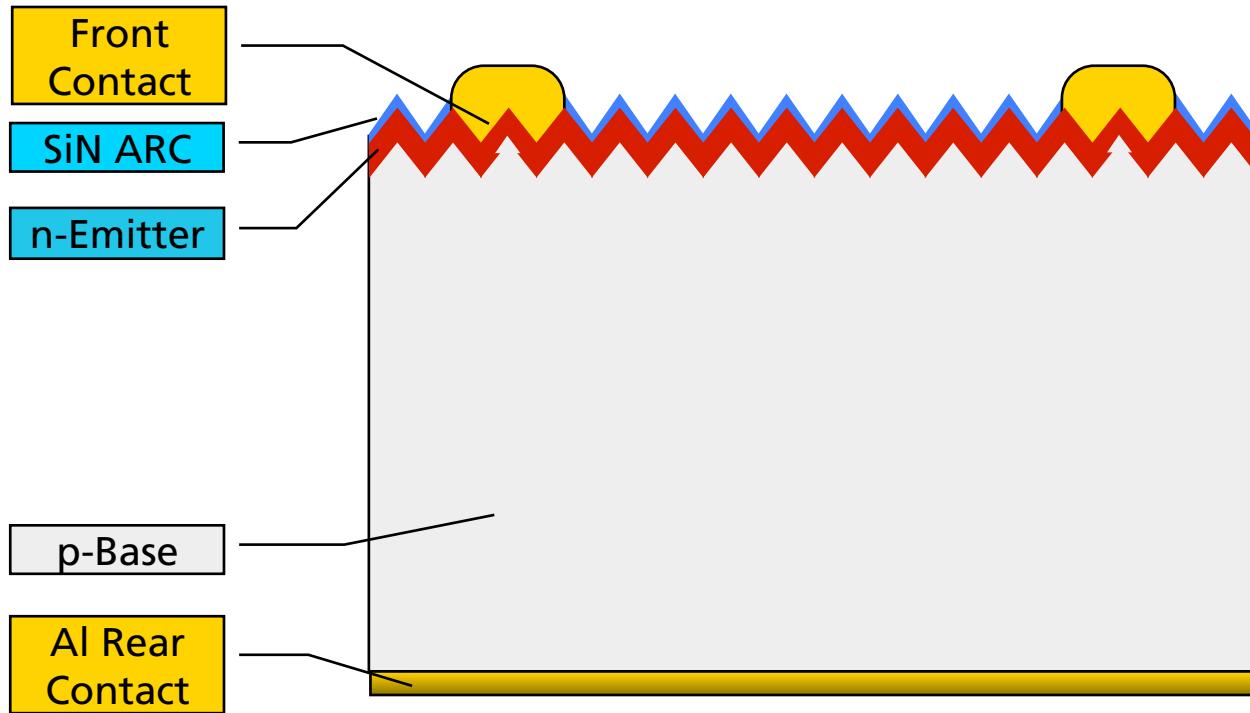
- Why high efficiencies?
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# General Strategy

## How to Achieve Highest Efficiencies?

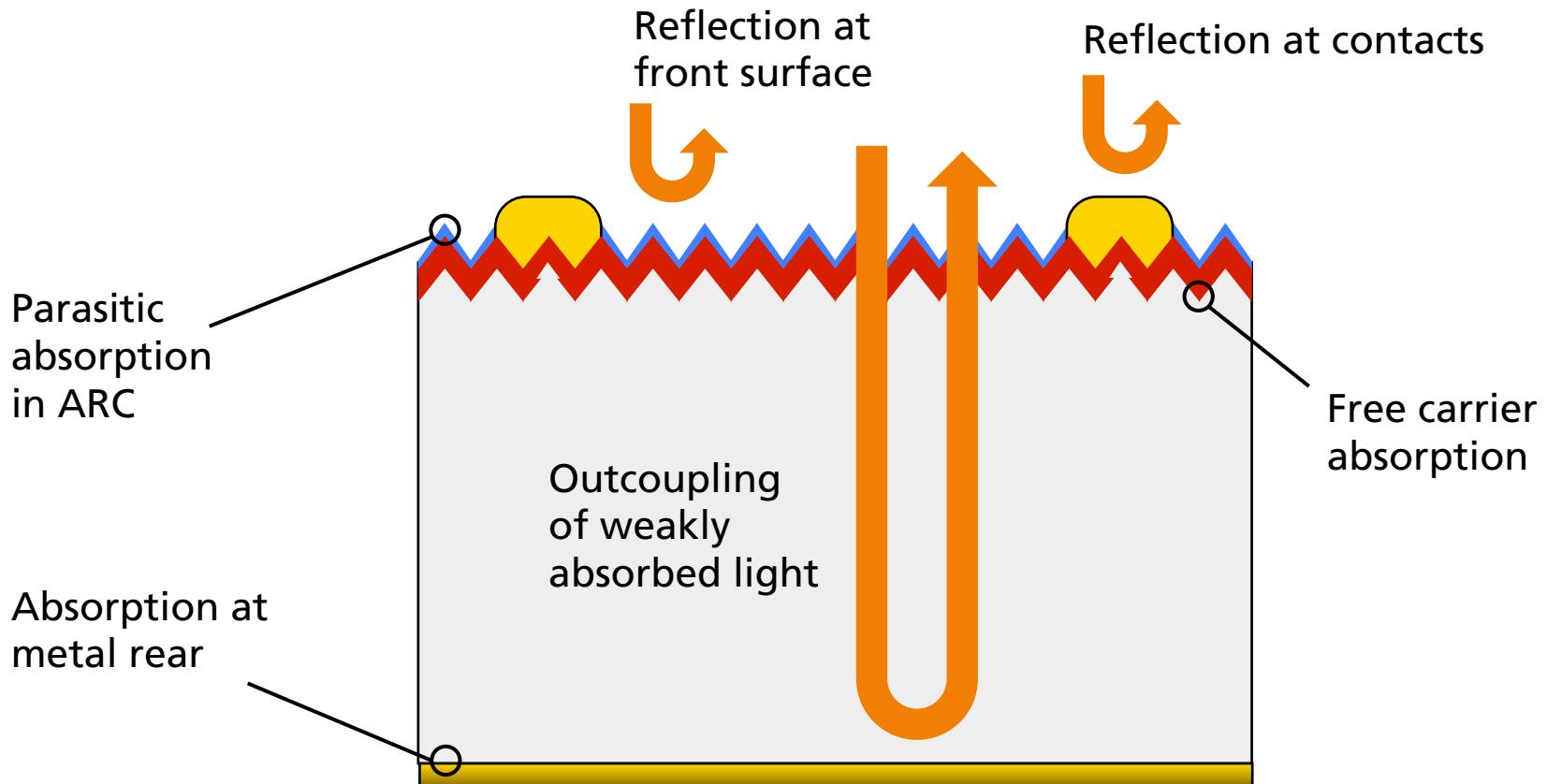


# Simple Crystalline Silicon Solar Cell

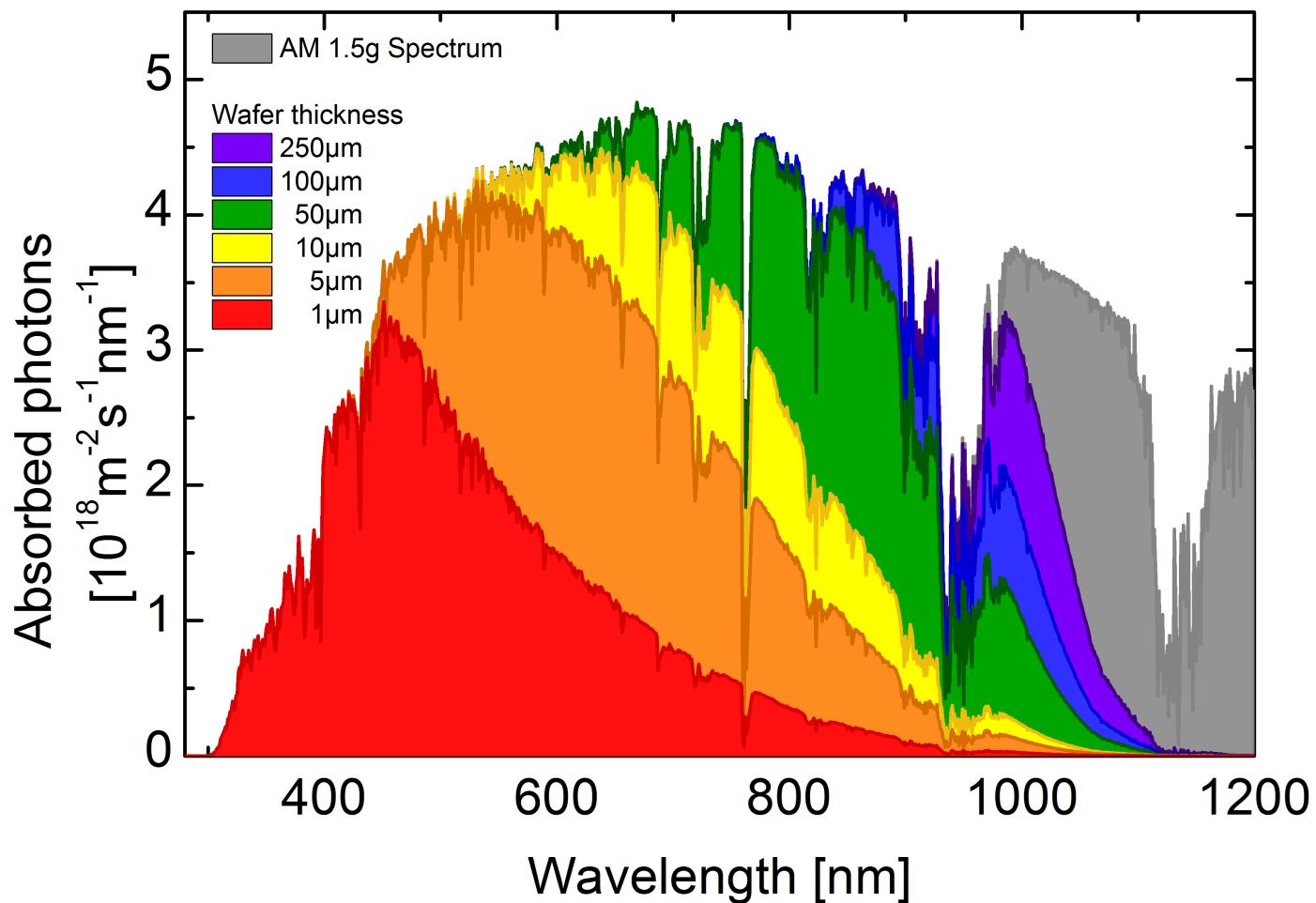


# Simple Crystalline Silicon Solar Cell

## Optical Losses

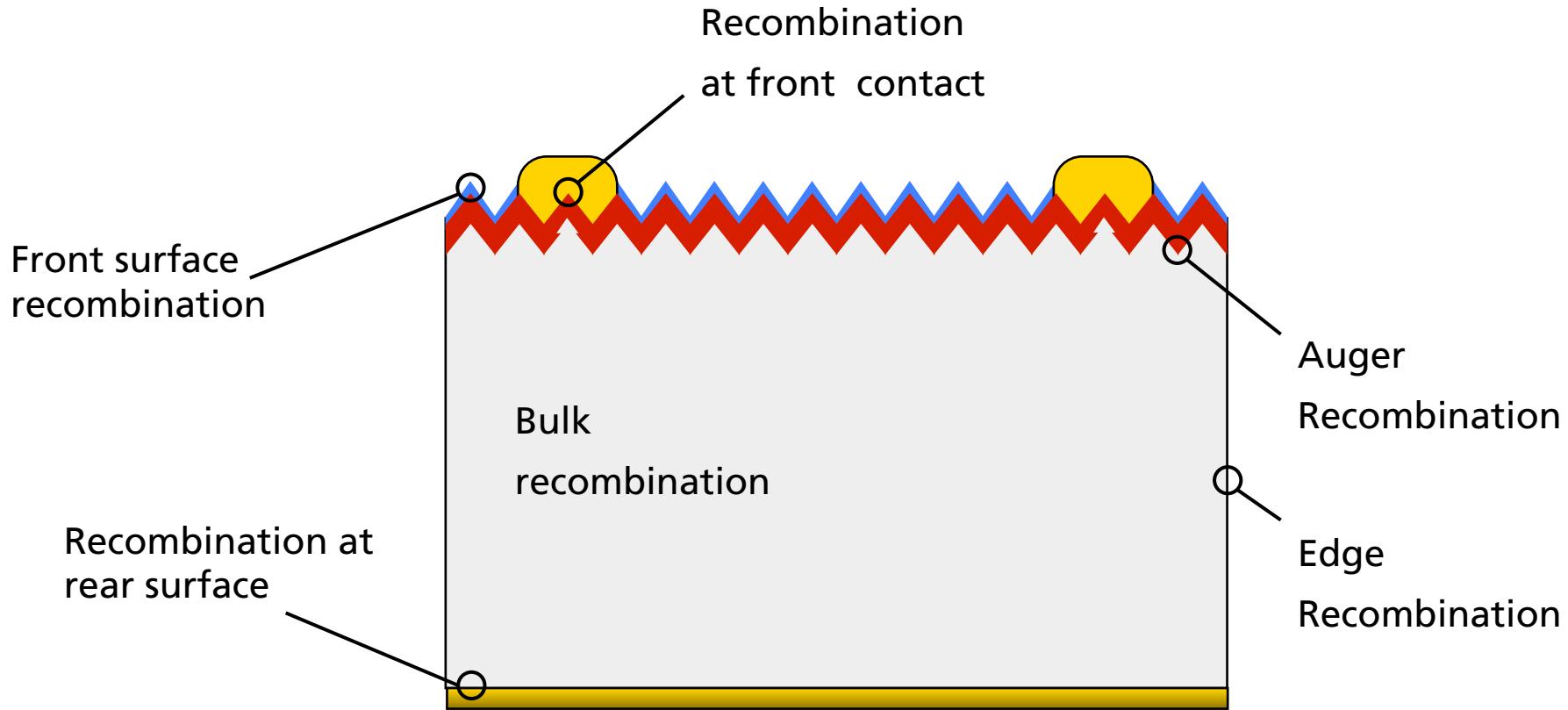


# Incomplete Absorption Challenge for Silicon Solar Cells



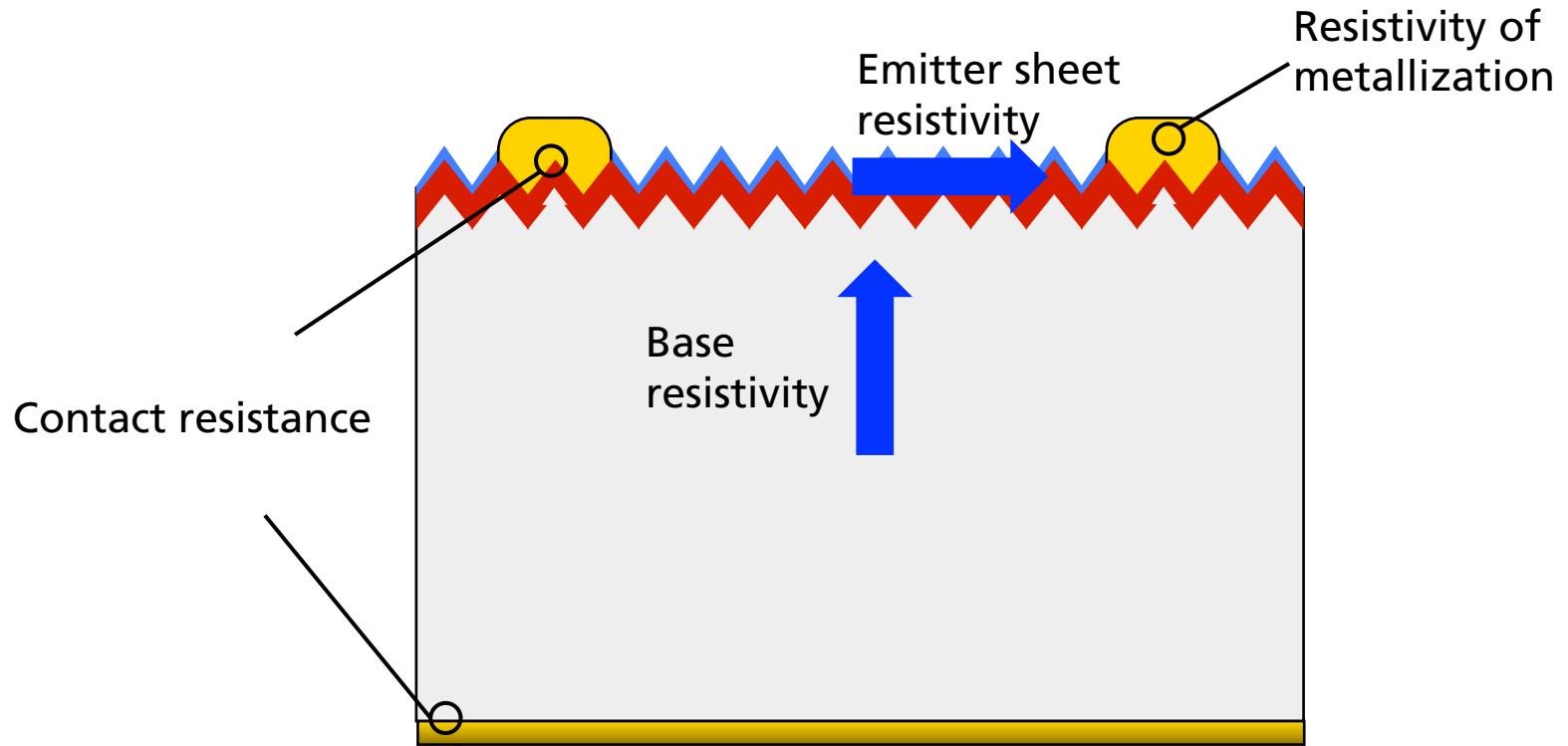
# Simple Crystalline Silicon Solar Cell

## Recombination Losses

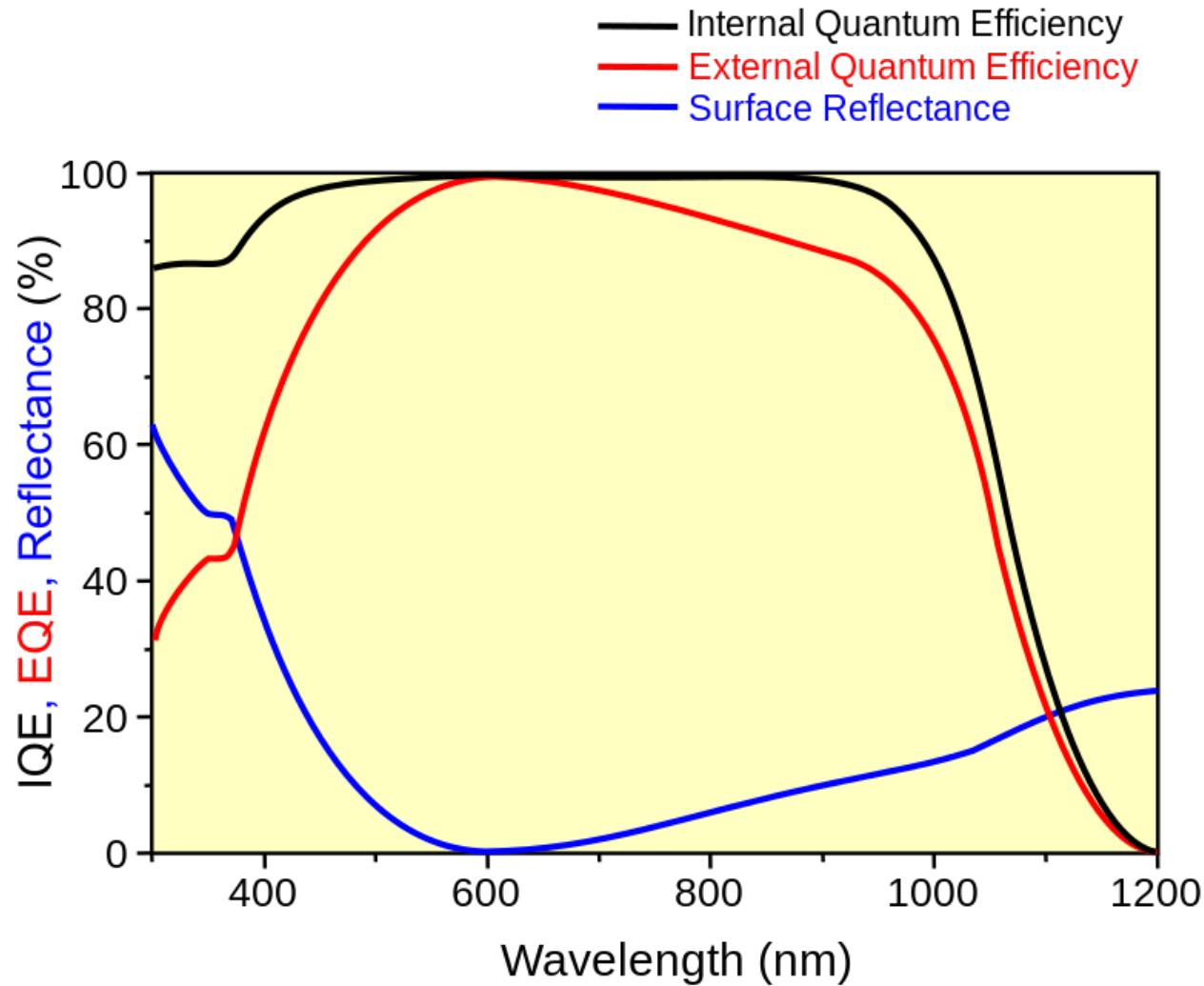


# Simple Crystalline Silicon Solar Cell

## Resistive losses



# EQE example



Source: Wikipedia [http://en.wikipedia.org/wiki/Quantum\\_efficiency#mediaviewer/File:Solarcellige-en.svg](http://en.wikipedia.org/wiki/Quantum_efficiency#mediaviewer/File:Solarcellige-en.svg)

# General Strategy for High Efficiencies

Reduce

1. optical,
2. recombination,
3. resistive

losses

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# AGENDA

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- Why high efficiencies?
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- General strategy for high efficiencies
- Analyzing and fixing main losses in different solar cell types – the leaky bucket
- Future steps

# What is the main loss of my cell?

## Fixing the leaky bucket

- To know what to tackle next you should know:  
What is my main loss?
- By reducing one recombination channel, the others can increase absolutely (not only relatively)

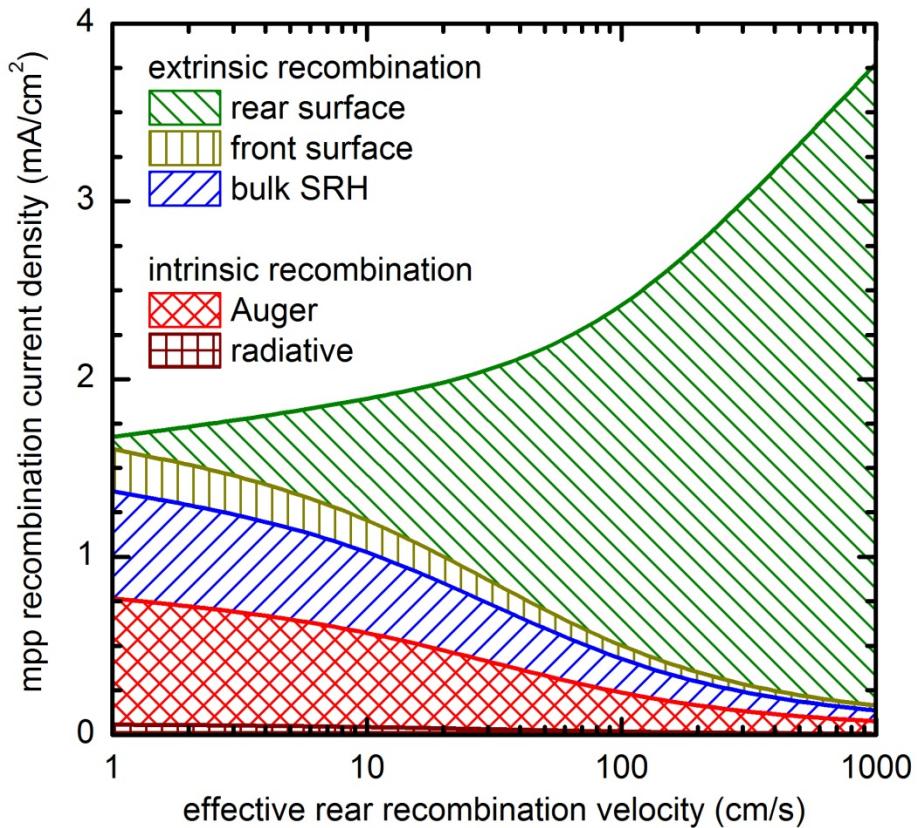


(S. Glunz, EUPVSEC 2012)

# What is the main loss of my solar cell?

## Recombination loss channels

- Recombination loss at mpp in a *n*-type solar cell with varying rear surface recombination
- By reducing one recombination channel, the others can increase absolutely (not only relatively)

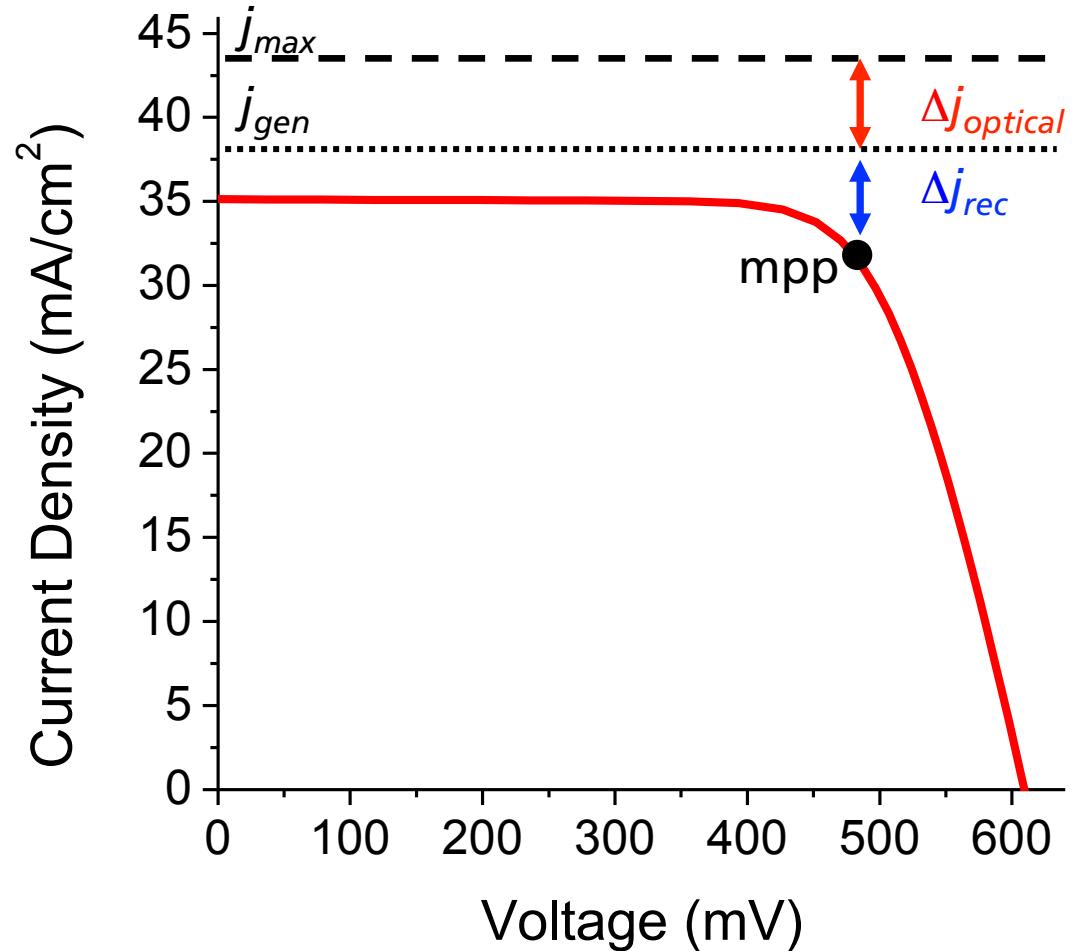


(A. Richter et al., Energy Procedia, SiliconPV 2012)

# What is the main loss of my cell?

## Analyzing loss currents

- $j_{max}$  = Theoretical maximum for a certain wafer thickness
- $j_{gen}$  = Generated photo-current in actual device
- Optical losses  $= j_{max} - j_{gen}$
- Recombination losses at mpp  $= j_{gen} - j_{mpp}$



# What is the main loss of my solar cell?

## Analyzing loss currents – Modeling

### Optical losses

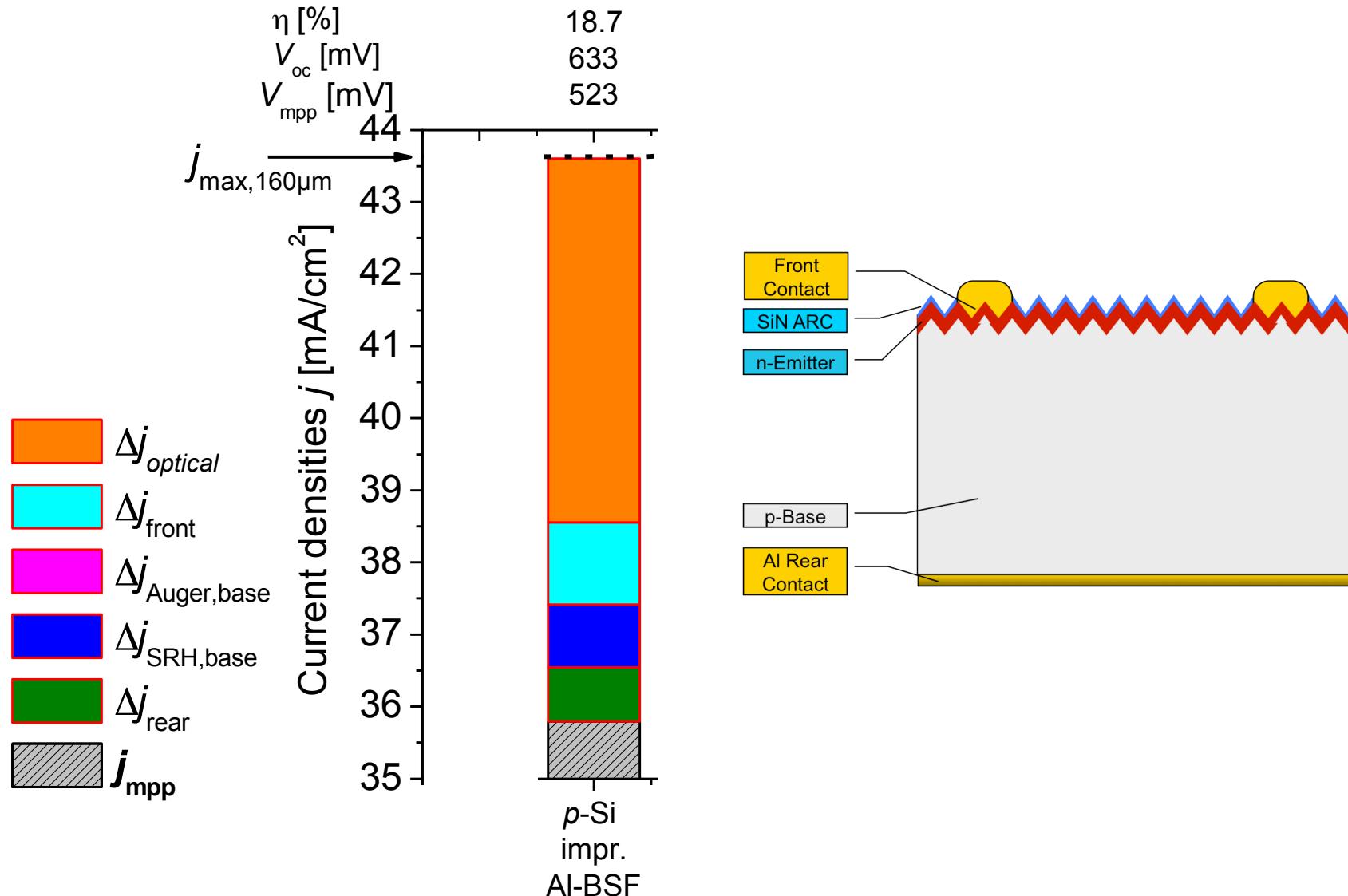
- $j_{max, 160\ \mu m}$  = Theoretical maximum for a 160  $\mu m$  thick wafer (43.6 mA/cm<sup>2</sup>)
- $j_{gen}$  = Generated photo-current in actual device (Raytracing simulation)

### Recombination losses

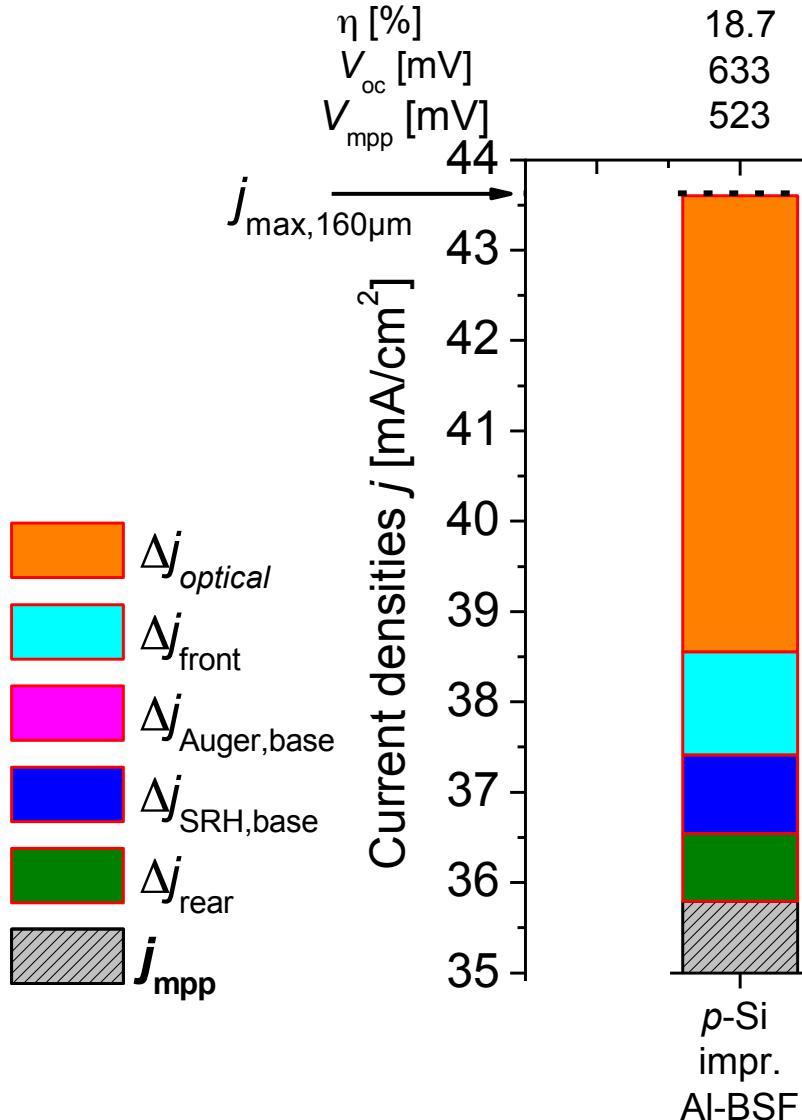
- Numerical 2/3 dimensional simulation with *consistent* set of parameters
- Spatial integration of recombination currents at mpp
- Distinguishing losses in different regions of the cell:
  - Front  $\Delta j_{front}$  (Emitter, IBC: FSF)
  - Base, Auger  $\Delta j_{Auger, base}$  (Undiffused region)
  - Base, SRH  $\Delta j_{SRH, base}$  (Undiffused region)
  - Rear  $\Delta j_{rear}$  (BSF, IBC: Rear Emitter + BSF)

### Resistive losses (taken into account but not shown)

# Al-BSF cell on p-type silicon



# Al-BSF cell on p-type silicon



## Main problem

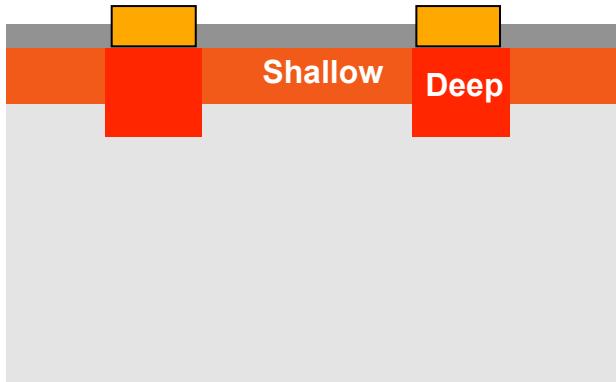
- Recombination losses in emitter (=front) due to high doping concentration and insufficient surface passivation

## Solution

- Selective emitters or paste which are able to contact lowly doped emitters

# Selective phosphorus emitters

## Process technologies



- $\Delta\eta = 0.3\% \dots 0.5\%$
- Different technological options:
  - Laser over-doping from PSG
  - Chemical etch-back of heavy emitter diffusion
  - Implanted emitter
  - Diffusion through a thin oxide opened in the finger region
  - Selective laser doping from spray-on phosphorus coating
  - Printing of P-dope or phosphorus-doped silicon ink
  - Laser-chemical processing

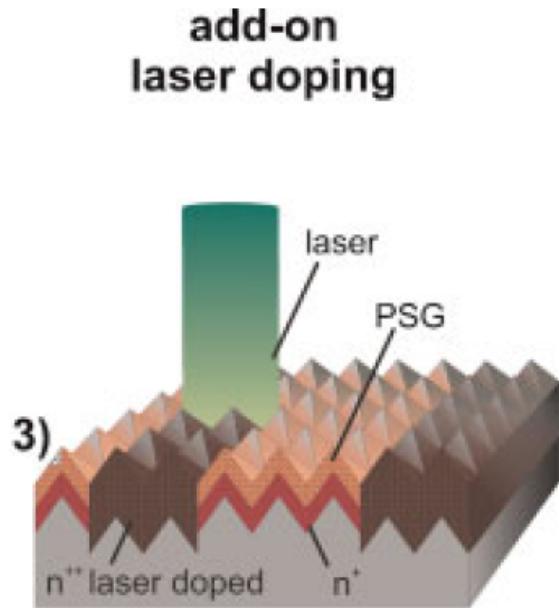
Good overview:

*G. Hahn et al.,*

*EU-PVSEC 2010, p. 1091*

# Selective phosphorus emitters

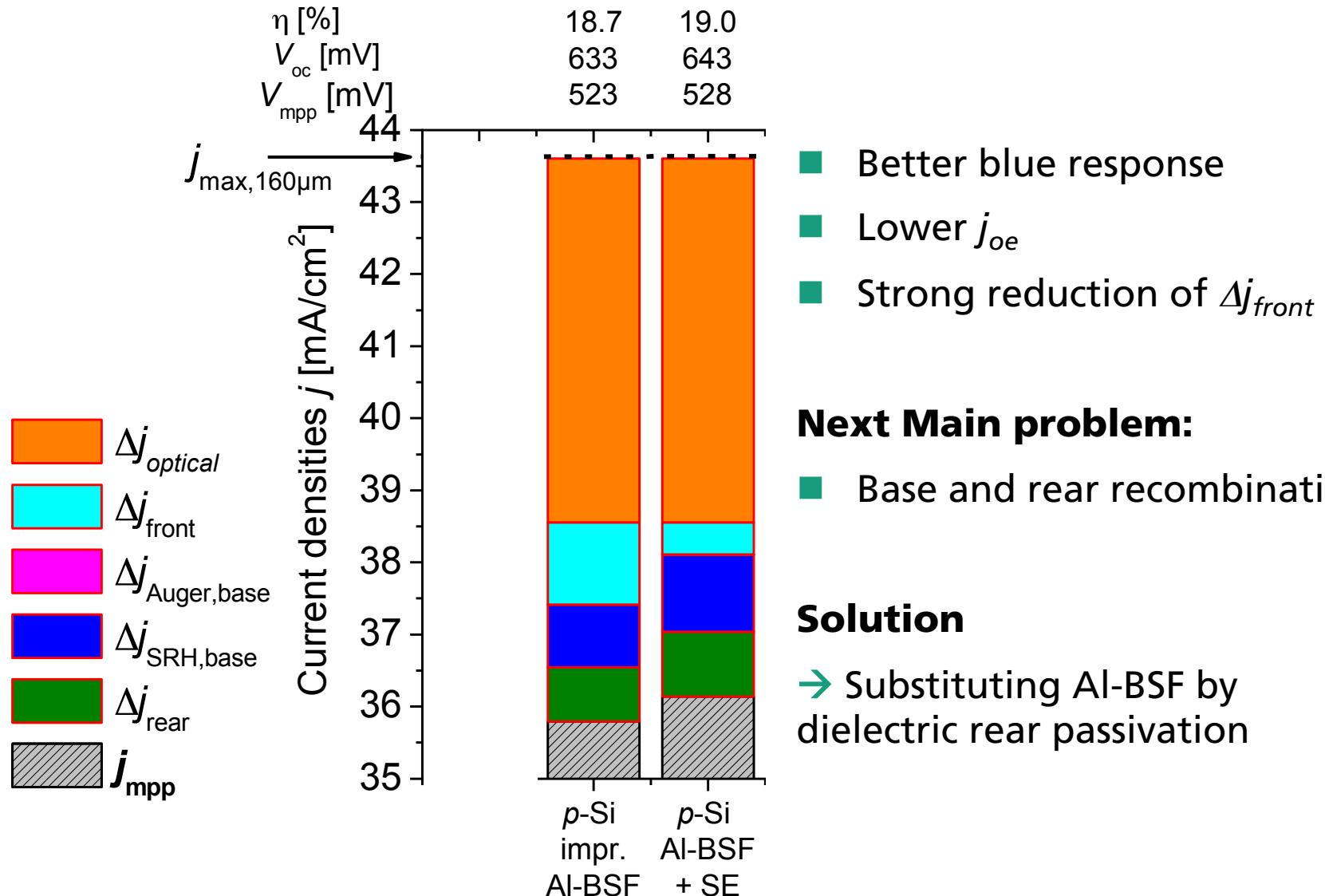
## Process technologies



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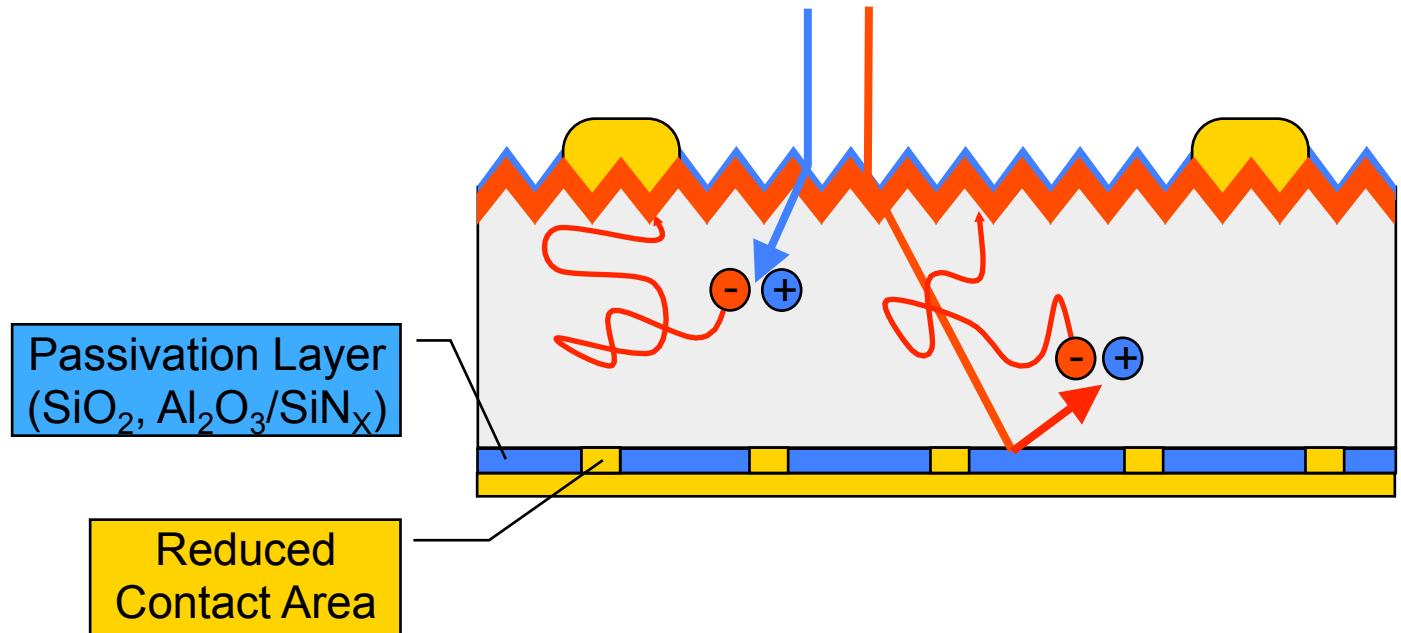
Röder et al., *Prog. Photovolt.* 18,  
p. 505 (2010)

# Al-BSF cell on p-type silicon with selective emitter



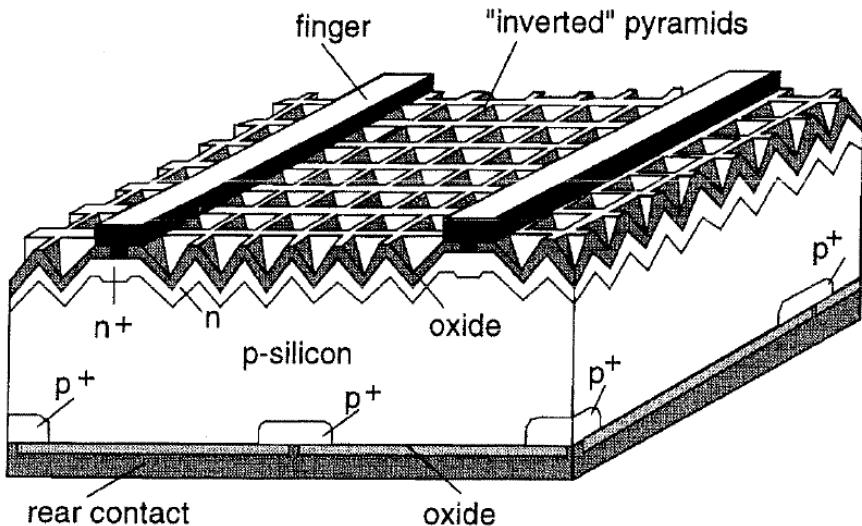
# High-efficiency cells with dielectrically passivated rear Optical and electrical rear reflector

- Reduction of rear recombination
- Better internal reflection



# High-efficiency cells with dielectrically passivated rear Optical and electrical rear reflector

- Reduction of rear recombination
- Better internal reflection
- Early world record with complex photo-lithographic processing

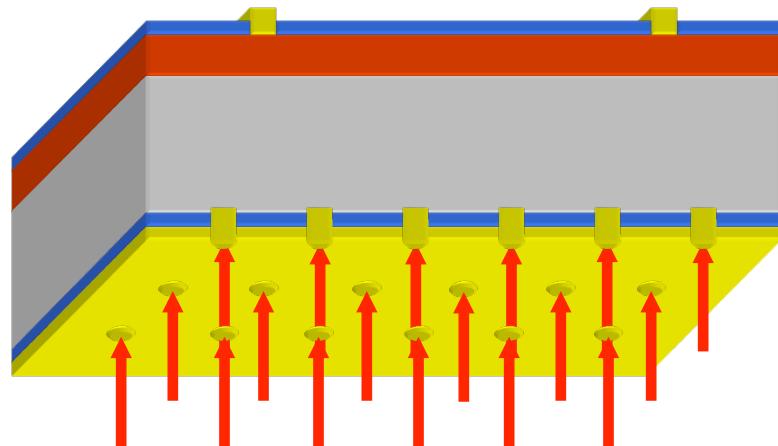


Company	Technology	Material	Area [cm <sup>2</sup> ]	Efficiency
UNSW J.Zhao, APL 73 1998	PERL	p-type FZ	4	25.0 %

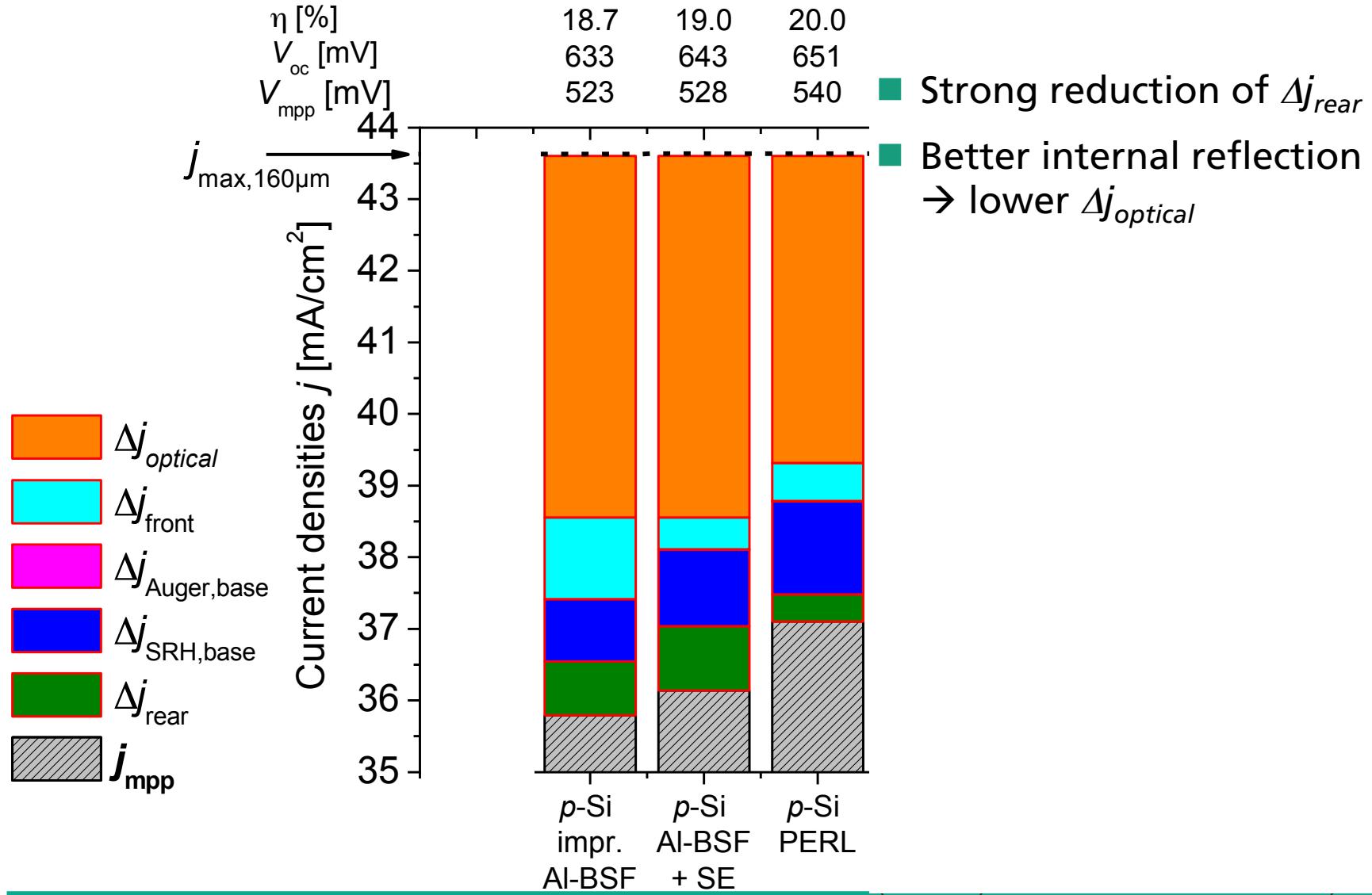
(M. Hermle, EUPVSEC 2014)

# High-efficiency cells with dielectrically passivated rear p-Type partial rear contact PRC

- Two additional process steps
  - Dielectric passivation
  - Local contact opening (LCO) or Laser fired contact (LFC)
- Can be used for **mc** und **Cz** silicon



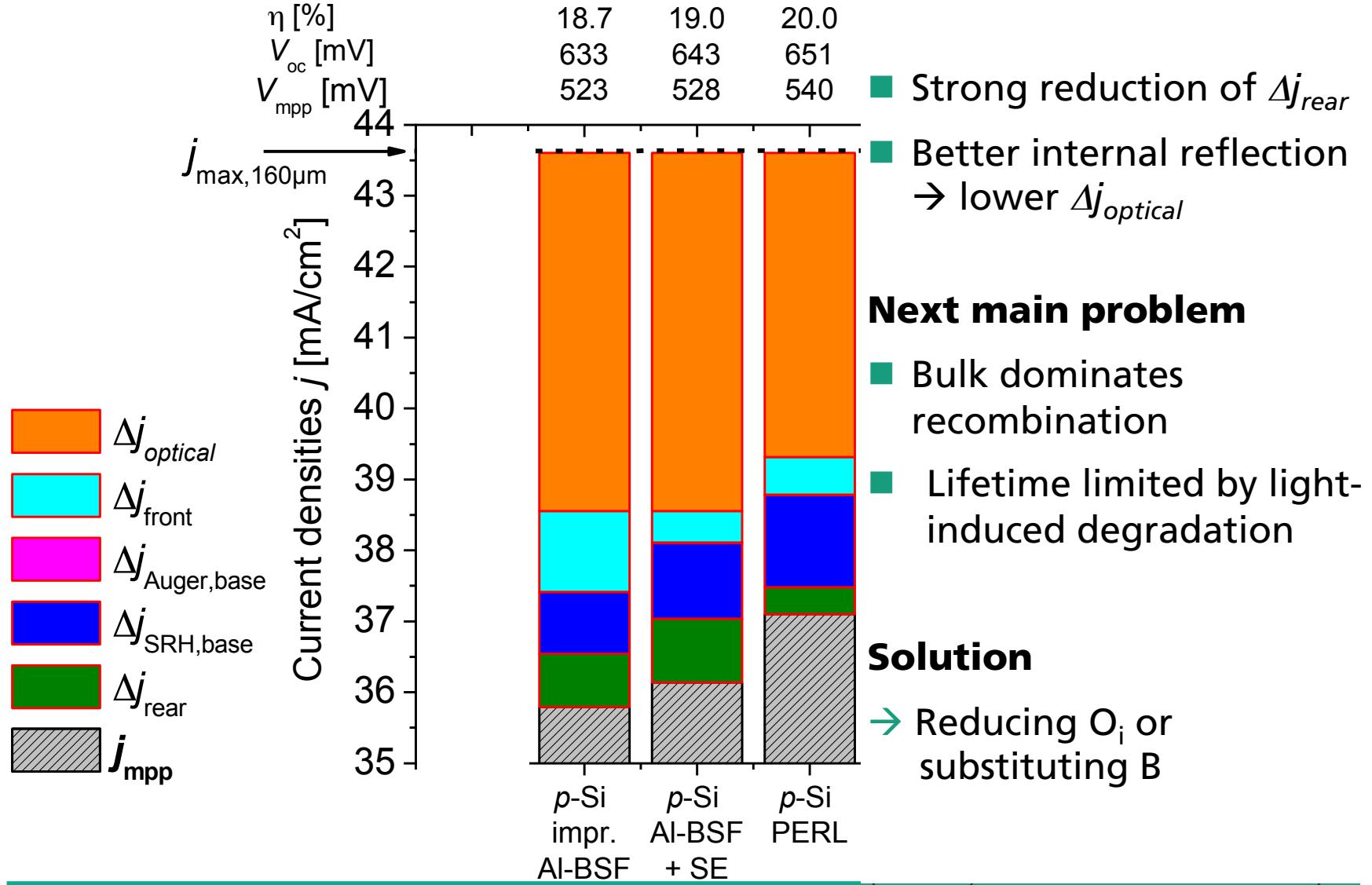
# High-efficiency cells with dielectrically passivated rear



# High-efficiency cells with dielectrically passivated rear p-Type PRC

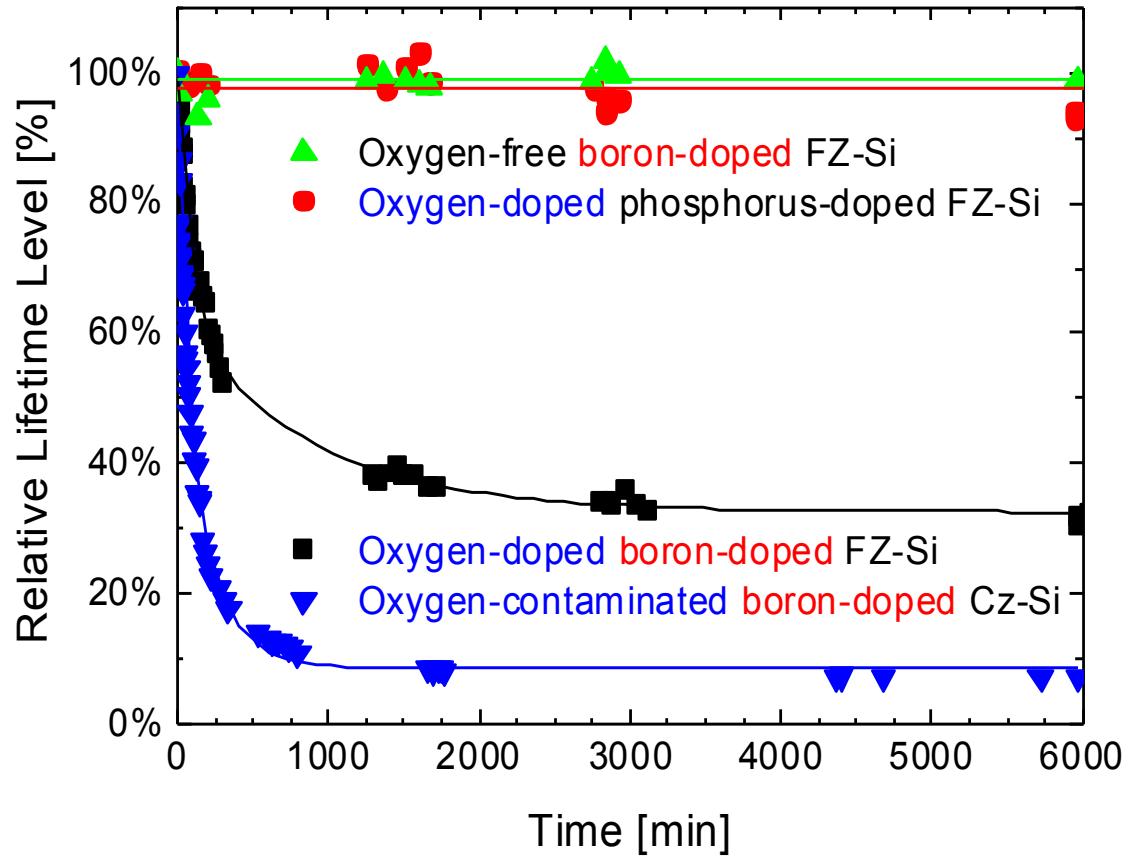
	<b>Mat- erial</b>	<b>V<sub>oc</sub> [mV]</b>	<b>J<sub>sc</sub> [mA/ cm<sup>2</sup>]</b>	<b>FF [%]</b>	<b>η [%]</b>	<b>Comment</b>
Q-Cells	mc	655	39,5	79,1	19,5	LFC for point contact P. Engelhart, EUPVSEC 2011
Gintech	mc	652	39,4	79,3	19,5	LCO for point contact Y.K.Chiou, Silicon PV 2014
Trina	Cz	662	39,1	79,4	20,5	P. Verlinden, Silicon PV 2014
Solar-world	Cz	672	39,2	79,3	20,9	High lifetime mono material G. Fischer, Silicon PV 2014
Schott	Cz	665	39,9	80,5	21,3	Electro plated front side A.Metz, SOLMAT 120 2014
ISFH	Cz	661	39,8	80,7	21,2	5 BB with dual print H.Hannebauer, PSS RRL 2014
ISE	MCz				21,3	Al-Foil LFC & Ni/Cu plated GridTOUCH measured A.Brand 2DO.2.5 and M. Graf 2CO.2.6

# High-efficiency cells with dielectrically passivated rear



# Reduced Minority Carrier Lifetime in Silicon Boron – Oxygen Complexes

- Additional bulk recombination in *p*-type Cz-grown silicon
- Light-induced degradation
- Metastable defect related to boron and oxygen<sup>1</sup>

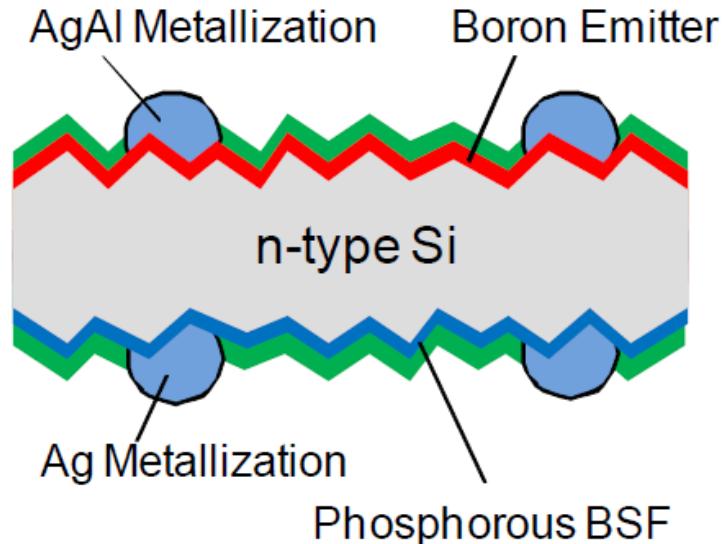


<sup>1</sup> Glunz et al., WCPEC/EUPVSEC, Vienna (1998)

# P-BSF cell on *n*-type silicon

## Bosch

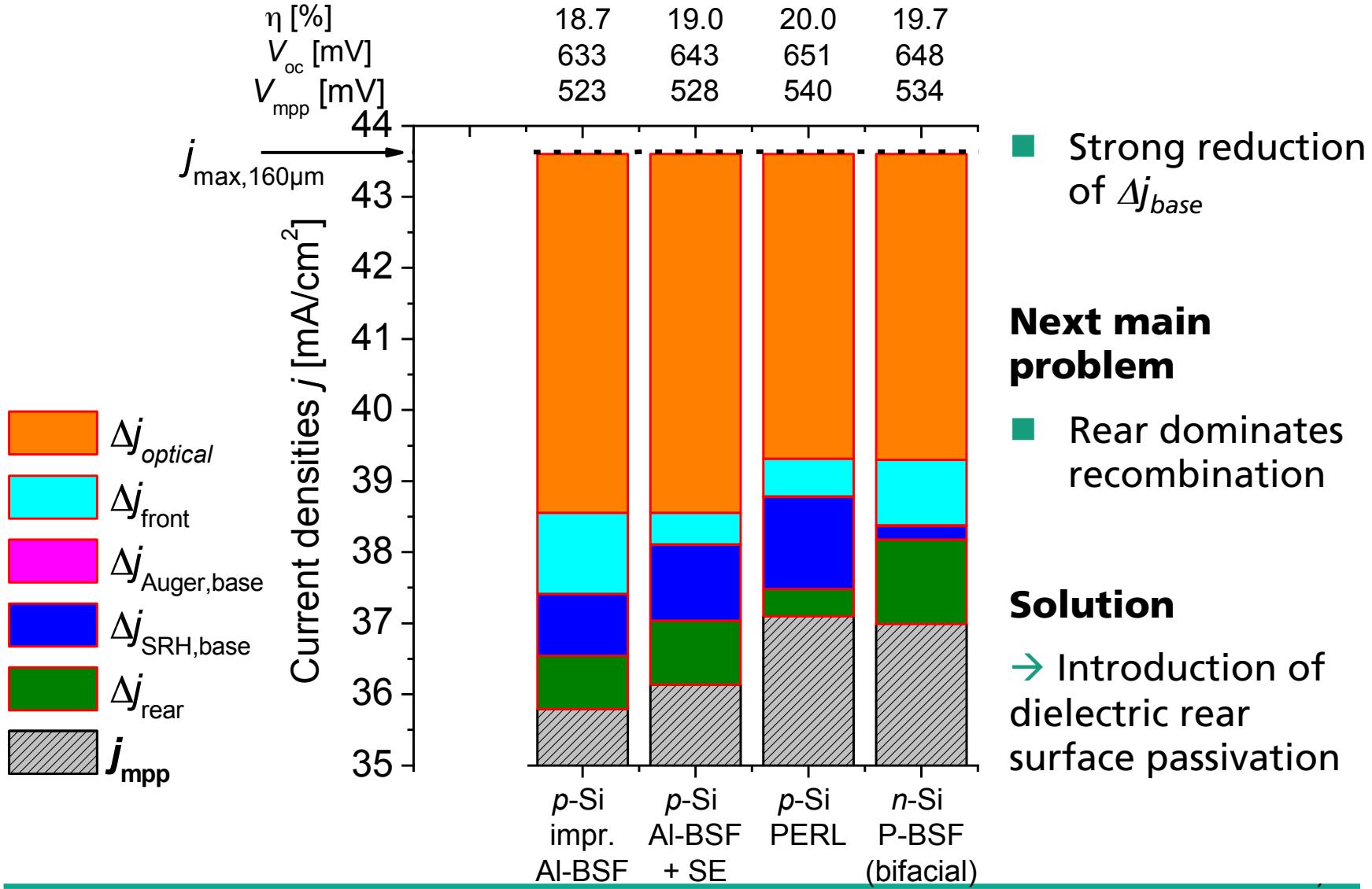
- Bifacial cell structure
- Reduced efficiency in comparison to mono-facial solar cell
- Higher yearly yield possible



Chuck	$V_{oc}$ [mV]	$J_{sc}$ [mA/cm <sup>2</sup> ]	FF	$\eta$ [%]
Gold coated	<b>648</b>	<b>39.1</b>	<b>79.5</b>	<b>20.1</b>
Black coated	<b>647</b>	<b>38.7</b>	<b>79.4</b>	<b>19.9</b>

Böscke et al., IEEE PVSC 2012

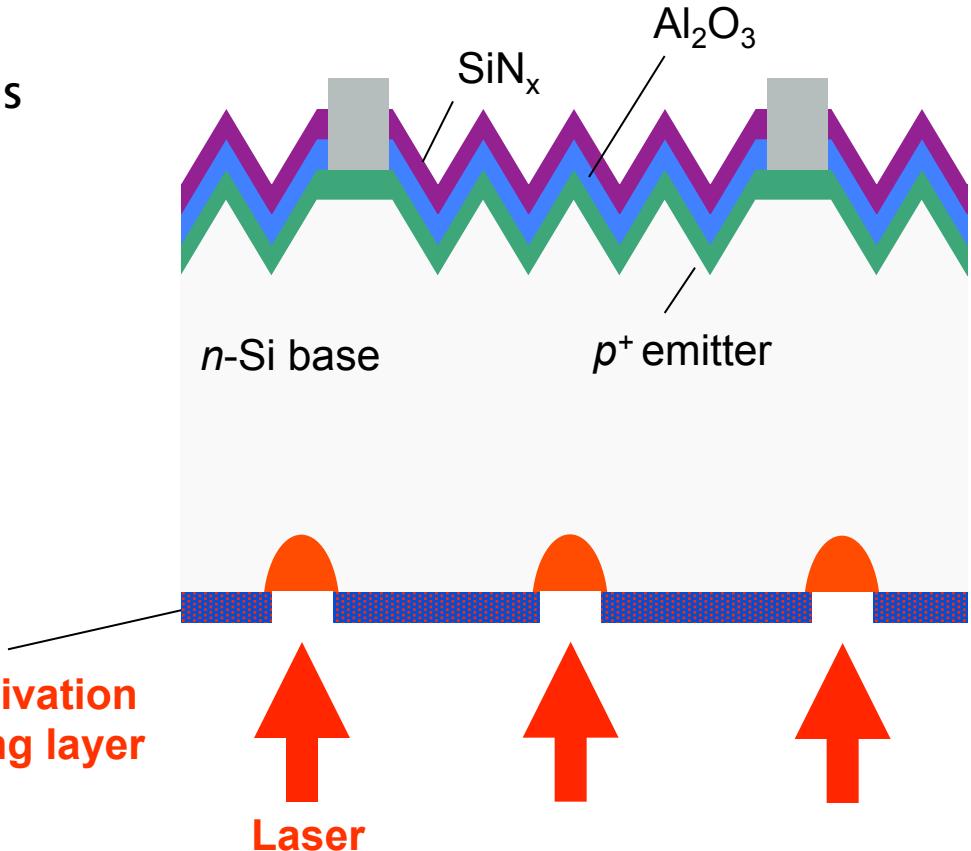
# P-BSF cell on *n*-type silicon



# PERL on *n*-type silicon

## Towards industrial high-efficiency cells

- Substitution of local phosphorus diffusion by laser doping from innovative double-function *PassDop* layer (passivation and doping)



D. Suwito et al., IEEE TED (2010)

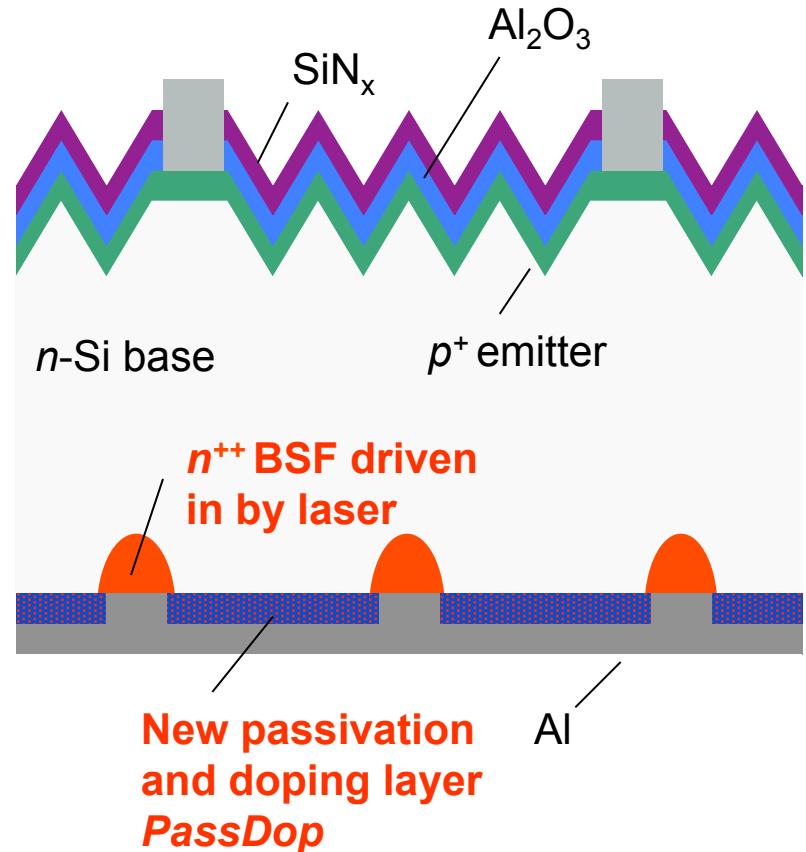
# PERL on *n*-type silicon

## Towards industrial high-efficiency cells

- Substitution of local phosphorus diffusion by laser doping from innovative double-function *PassDop* layer (passivation and doping)
- Excellent results with evaporated front contacts

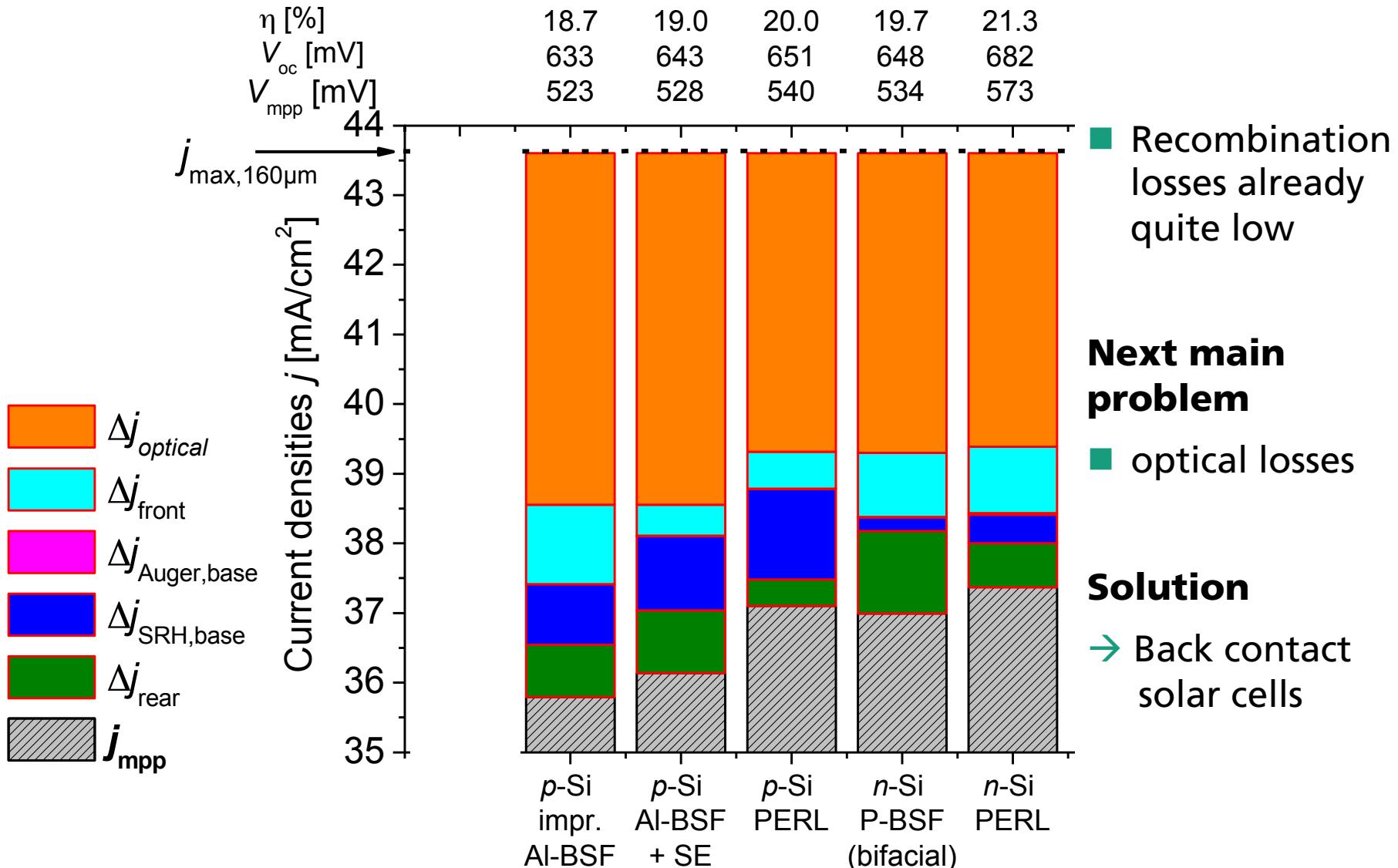
	$V_{oc}$ [mV]	$J_{sc}$ [mA/cm <sup>2</sup> ]	FF [%]	$\eta$ [%]
Best cell	701	39.8	80.1	22.4*

\*Confirmed at Fraunhofer ISE CalLab



D. Suwito et al., IEEE TED (2010)

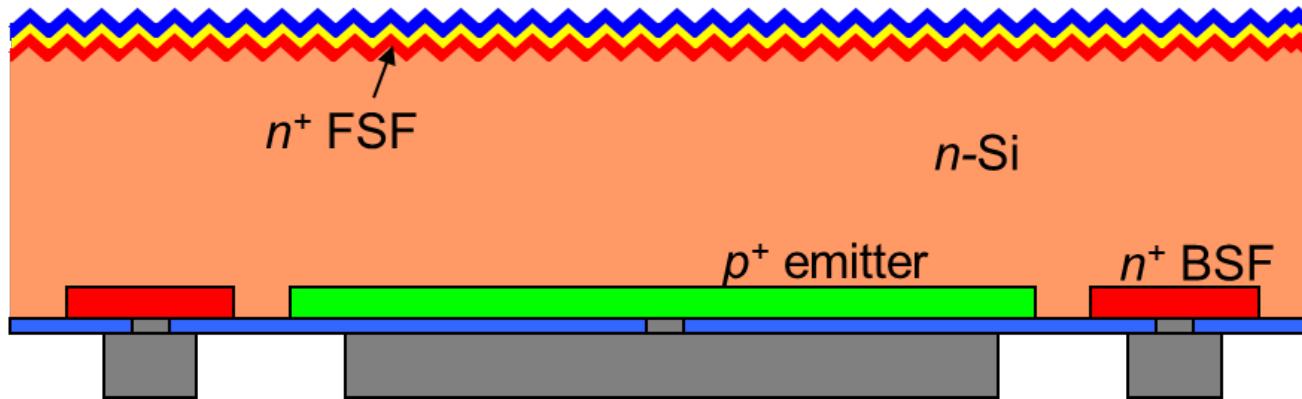
# PERL cells on $n$ -type silicon



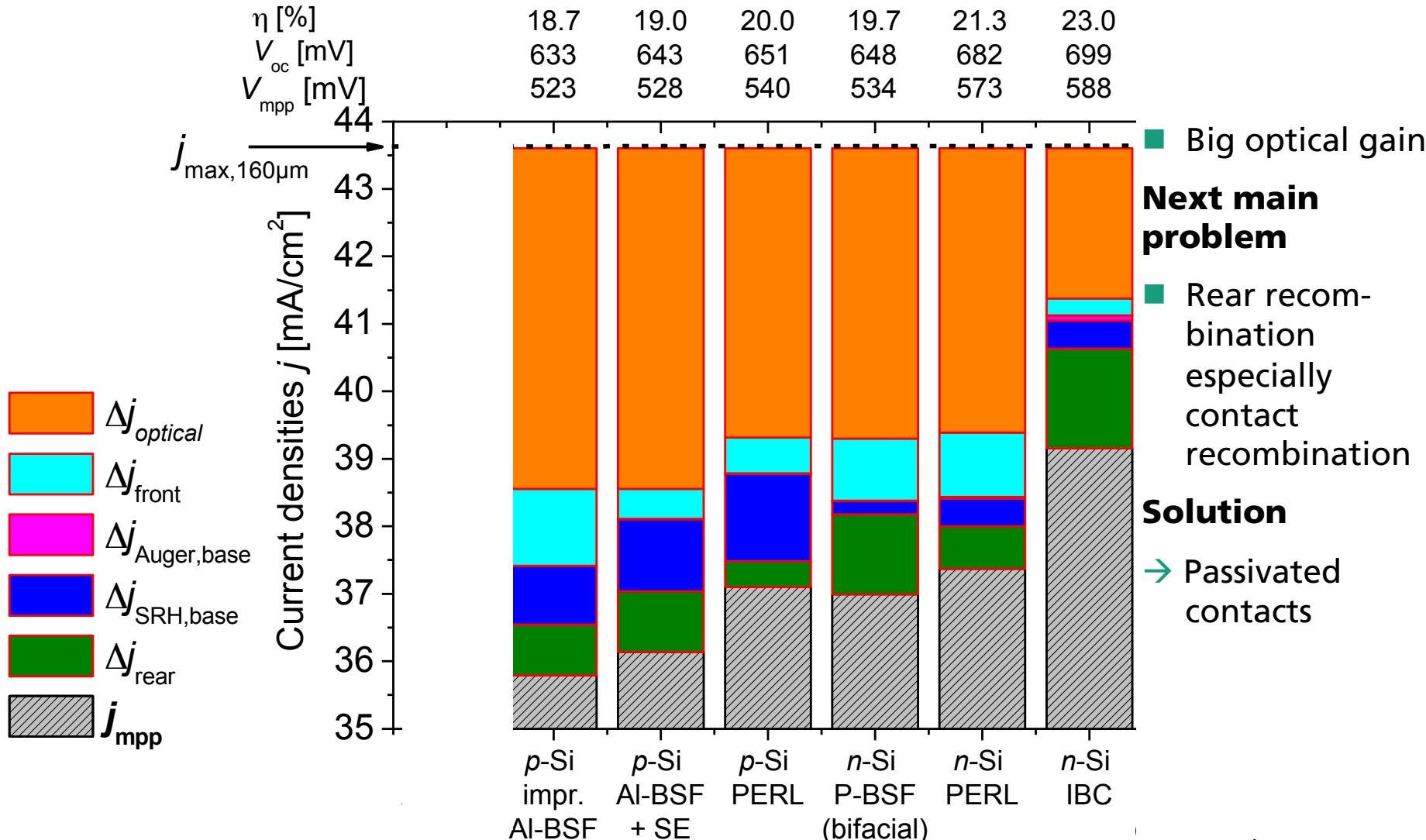
# Solar Cell Concept to Close the Gap

## n-Type BJBC – without “passivated contacts”

- Large volume production by Sunpower since more than 10 years



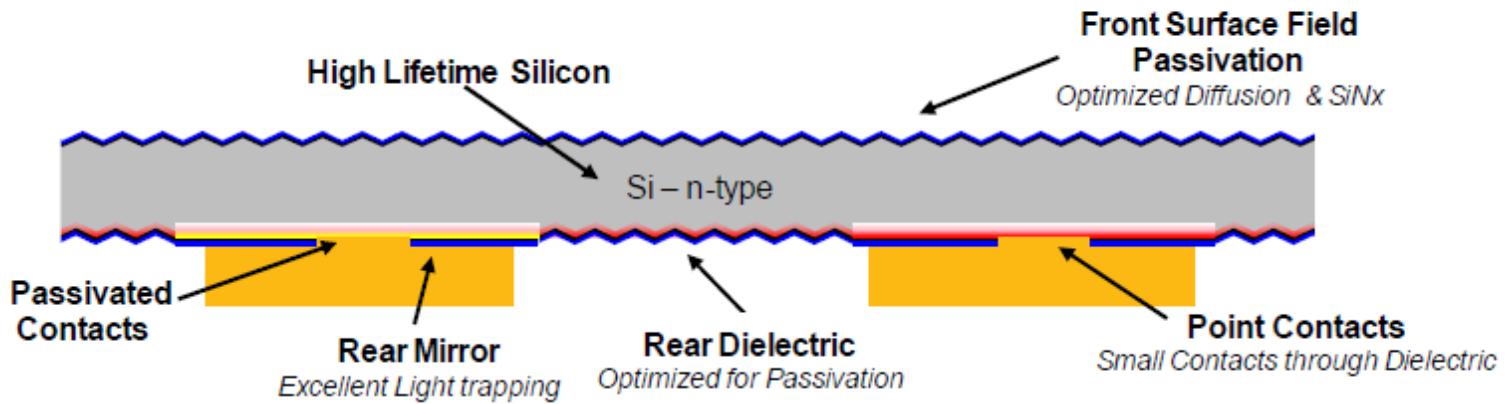
# IBC cell on *n*-type silicon



# Towards the Limit

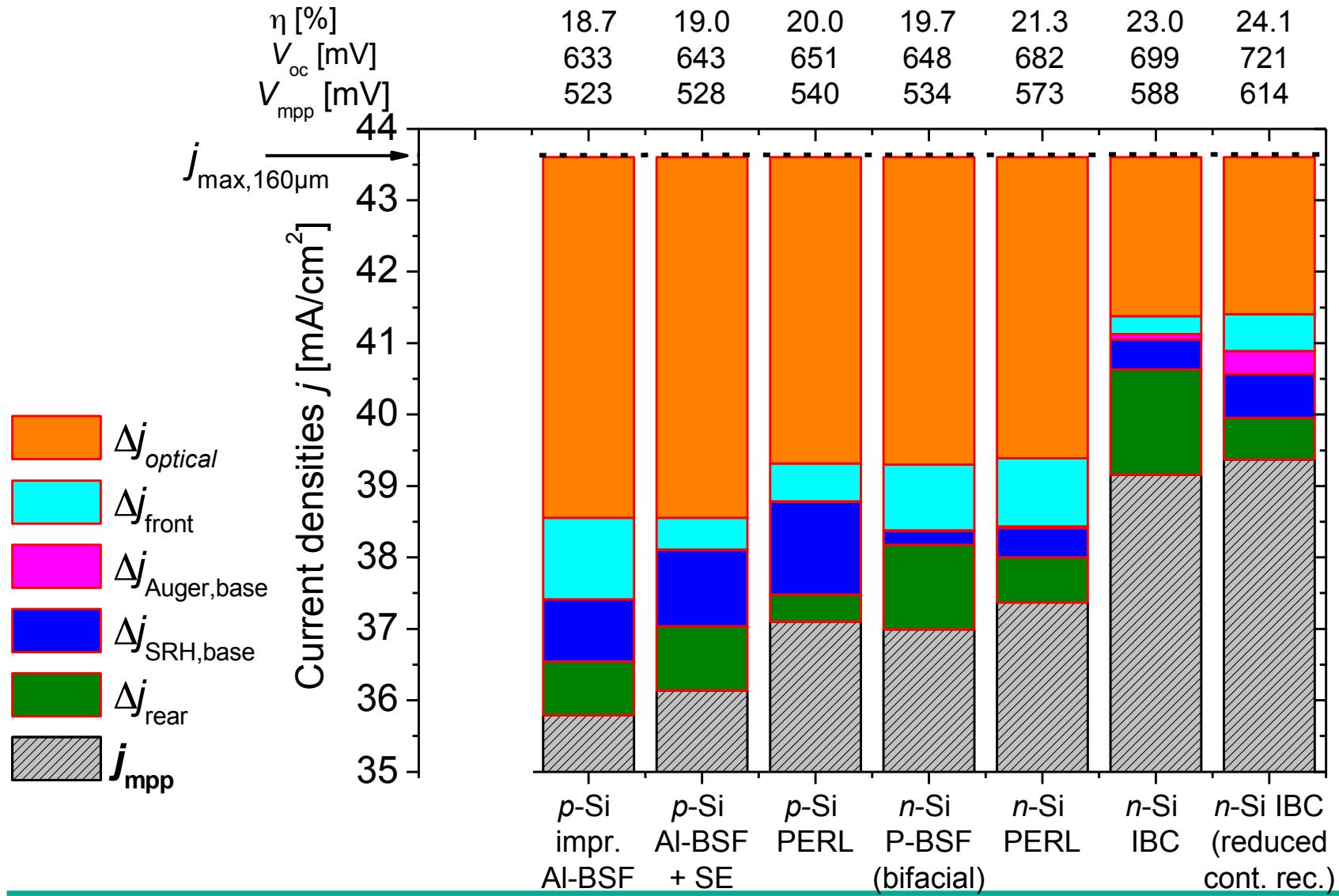
## IBC cell with passivated contacts on n-type silicon

- Interdigitated back contact back junction solar cells
- Excellent contact passivation
- SunPower<sup>2</sup> ( $a_p=121 \text{ cm}^2$ ) 25.0% ( $V_{oc} = 726 \text{ mV}$ )
- Edge losses are getting crucial



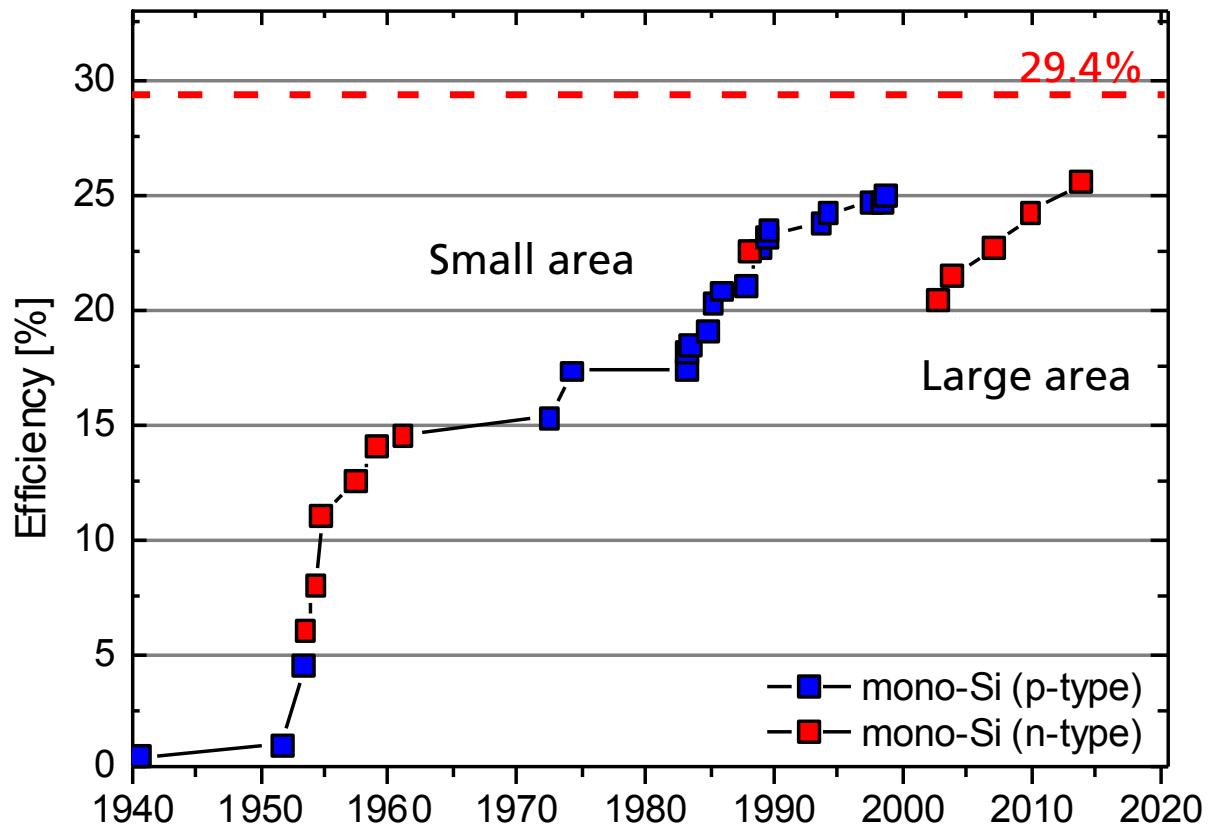
SunPower  
<sup>2</sup> Smith et al., IEEE PVSC (2014)

# IBC cell with passivated contacts on *n*-type silicon



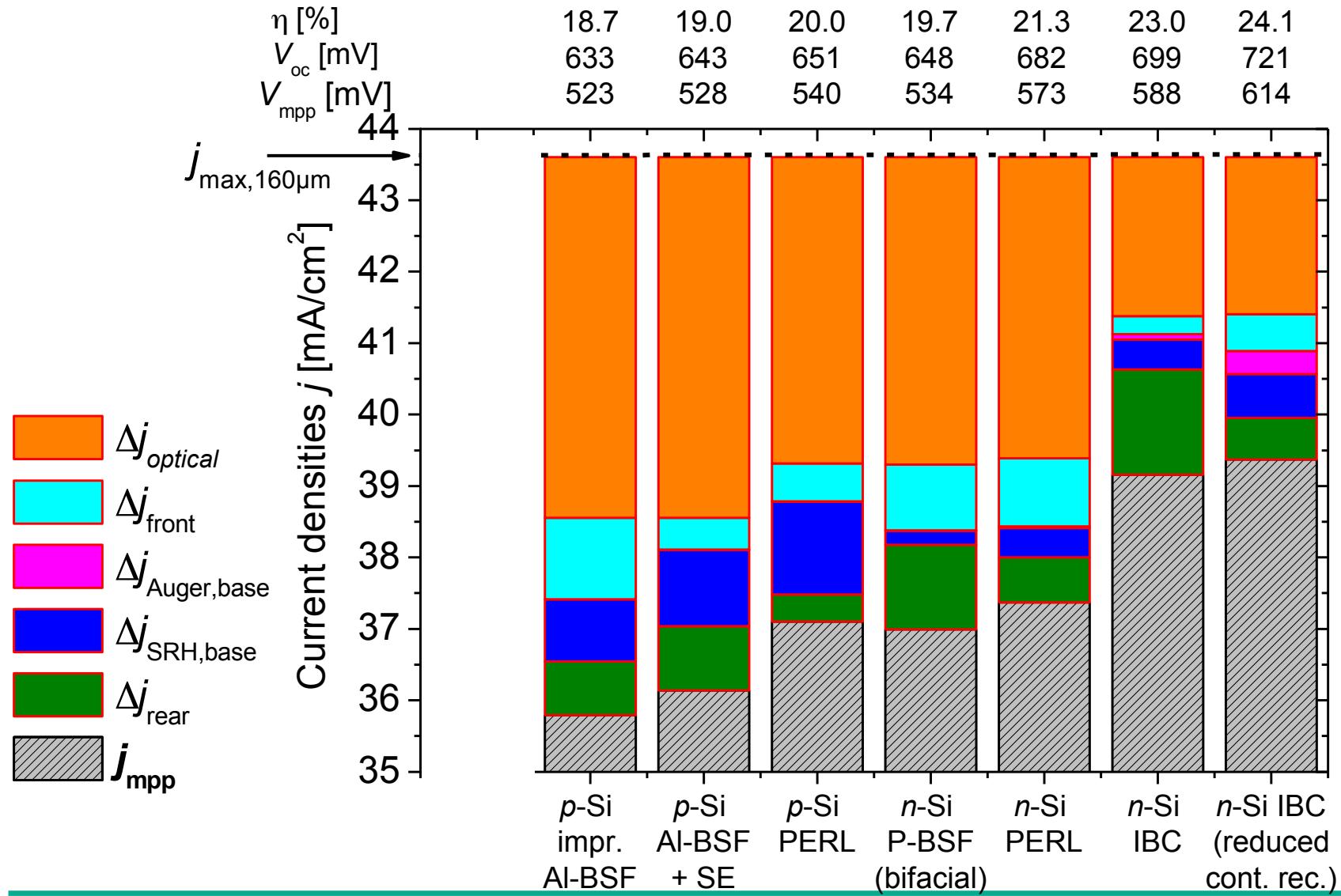
# Towards the Limit Large-area Record Cells

- Large-area  
(Sunpower, Sanyo/  
Panasonic)
- Extremely high  
lifetimes needed  
( $> 1$  ms)
- Usage of  $n$ -type  
silicon to avoid  
light-induced  
degradation



(S. Glunz, EUPVSEC 2014)

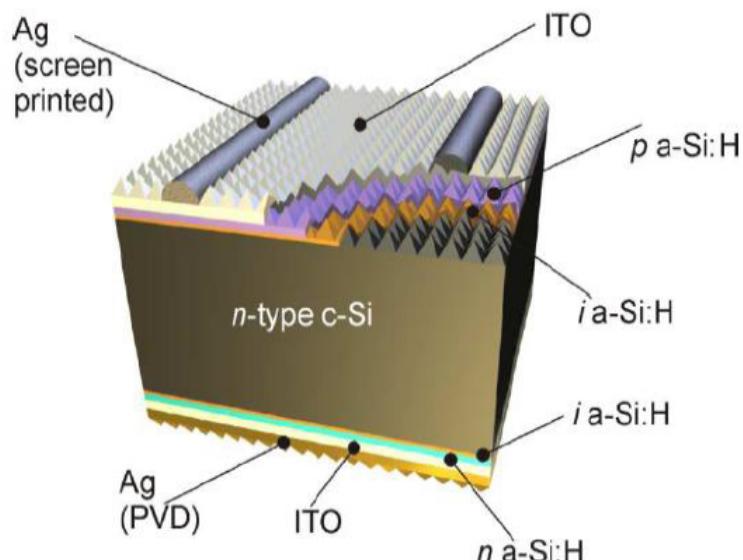
# IBC cell with passivated contacts on *n*-type silicon



# n-Type Heterojunction

## A “simple” cell structure

- Lean process flow
- Highly efficient carrier selective contacts
- High  $V_{oc}$  and low  $T_k$
- High efficiencies for thin wafers



from: D.Bätzner Silicon PV 2014

# n-Type Heterojunction

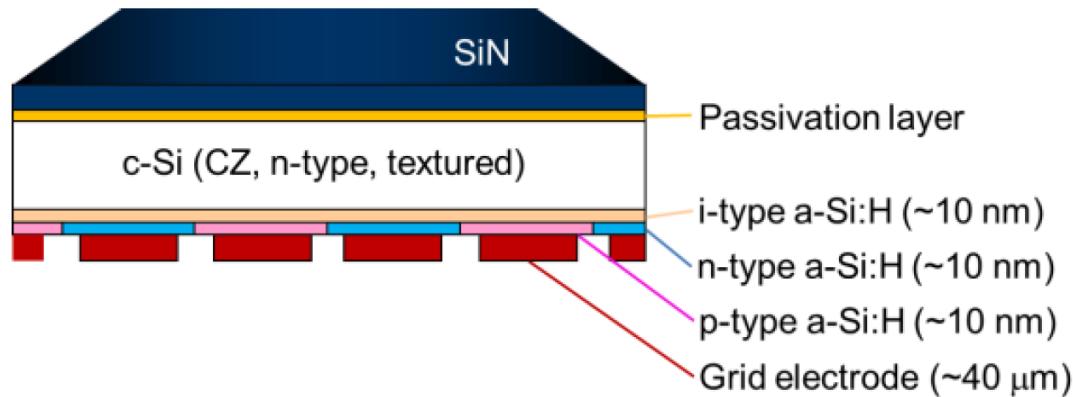
## A “simple” cell structure

	<b>Area [cm<sup>2</sup>]</b>	<b>V<sub>oc</sub> [mV]</b>	<b>J<sub>sc</sub> [mA/cm<sup>2</sup>]</b>	<b>FF [%]</b>	<b>η [%]</b>	<b>Comment</b>
Silevo	239	<b>739</b>	39,9	80,5	<b>23,1</b>	Tunnel oxide passivation J.Heng 40th IEEE PVSC 2014
R&R	239	<b>736</b>	38,6	81,3	<b>23,1</b>	Smart wire no BB GridTOUCH measured D.Bätzner, Silicon PV 2014
Choshu	239	<b>733</b>	37,3	81,8	<b>22,3</b>	Rear Emitter cell J. Nakamura, nPV Workshop 2013
CEA-INES	105	<b>730</b>	38,7	78,8	<b>22,3</b>	PJ. Riberon, Silicon PV 2014
Kaneka	171	<b>738</b>	40	81,9	<b>24,2</b>	Copper plated front grid JL. Hernandez, EUPVSEC 2013
Panasonic	101.8	<b>750</b>	39,5	83,2	<b>24,7</b>	98 µm thin wafer M. Taguchi, IEEE JPV 2013

# Towards the Limit

## Hetero BCBJ Record Cell

- Interdigitated back contact back junction solar cells
- Excellent contact passivation (a-Si/c-Si heterojunction)
- Sanyo<sup>1</sup> ( $da=143.7 \text{ cm}^2$ ) 25.6% ( $V_{oc} = 740 \text{ mV}$ )



Panasonic/Sanyo  
¹ Masuko et al., IEEE PVSC (2014)

# Fighting against losses

- *Improving the front side:* Selective emitters
- *Improving the rear:* Dielectric passivation and point contacts
- *Improving the base:* Transition to n-type silicon
- *Reducing the optical losses:* Rear contact cells
- *Getting rid of the last (?) recombination:* Passivated contacts



## What next ?

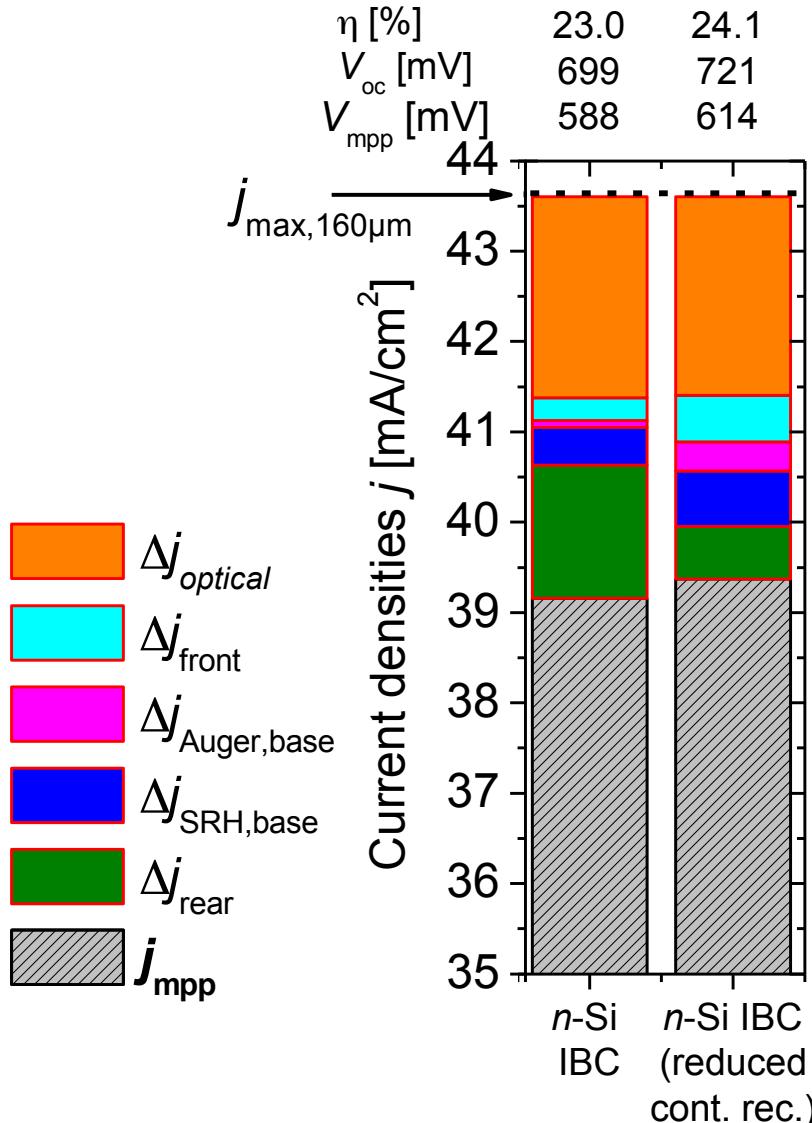
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- Why high efficiencies?
- What is the efficiency limit for silicon solar cells?
- General strategy for high efficiencies
- Analyzing and fixing main losses in different solar cell types – the leaky bucket
- Future steps

# What limits the IBC cell with passivated contacts?



## Next main problems

- Volume recombination (Auger and SRH)
- Surface recombination

## Solution

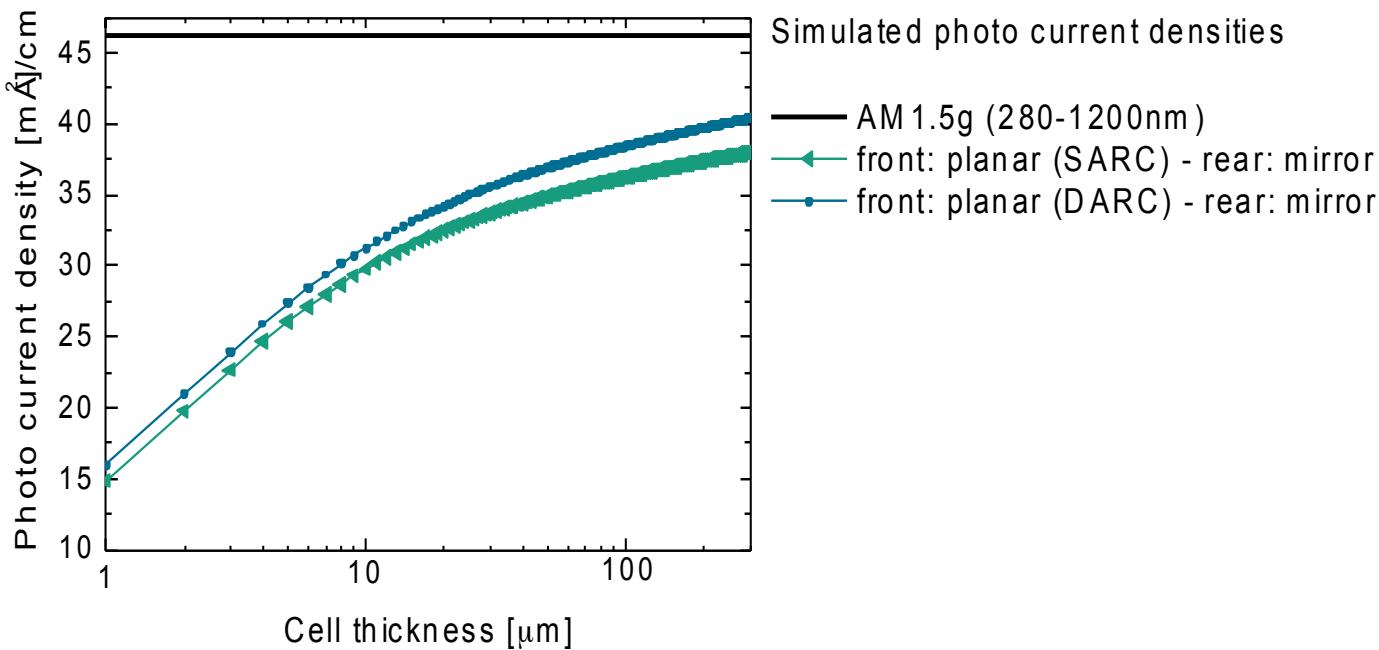
- Thinner wafer
- Flat silicon surfaces

**Electrically thin, but optically thick solar cells**

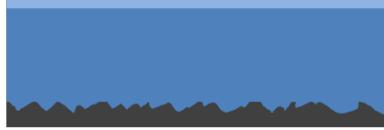
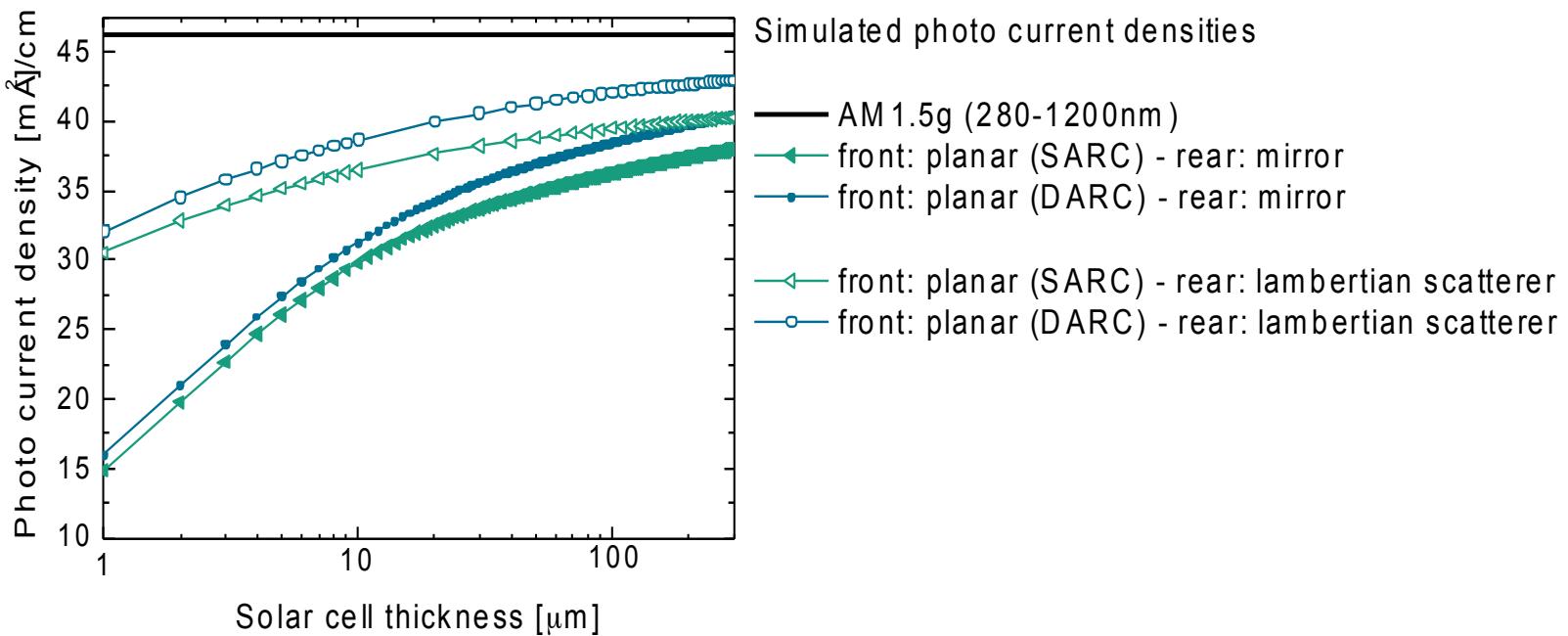
**with**

**Electrically flat, but optically rough surfaces**

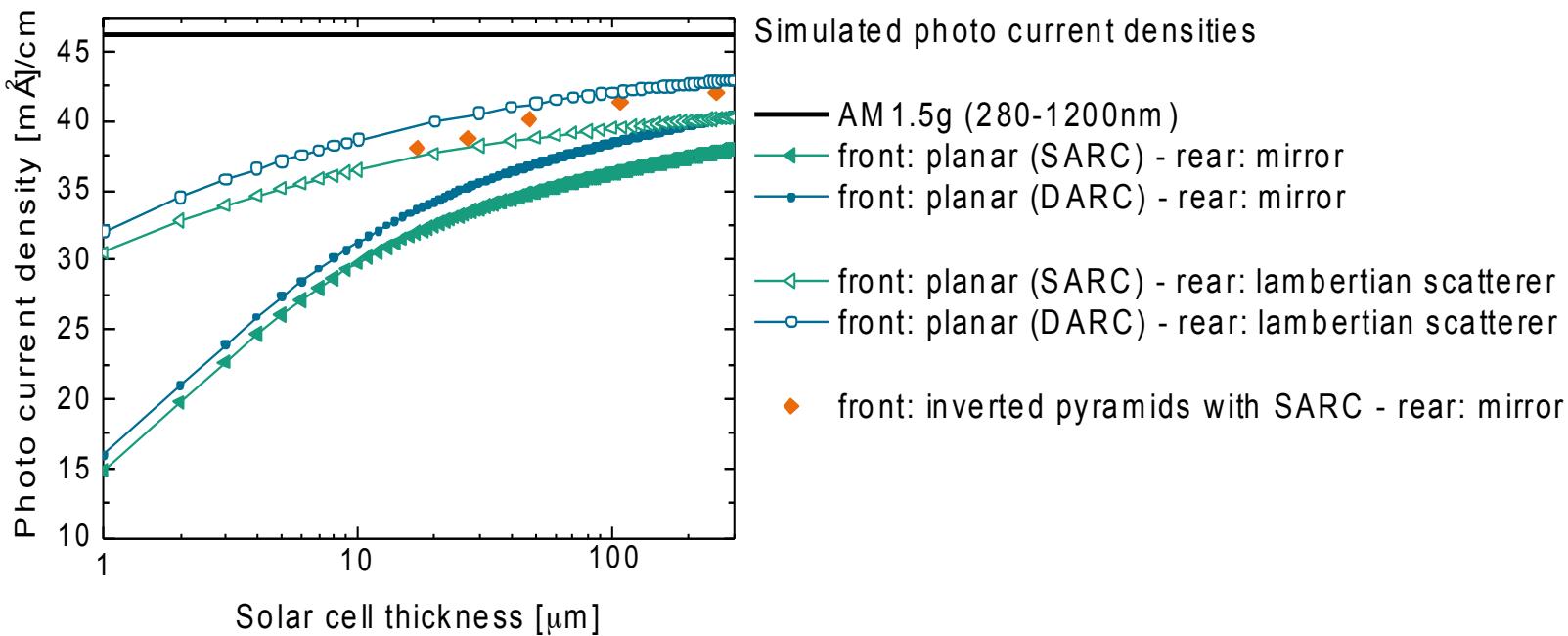
# Increasing Light Absorption Flat Surfaces



# Increasing Light Absorption Scattering Rear Surfaces

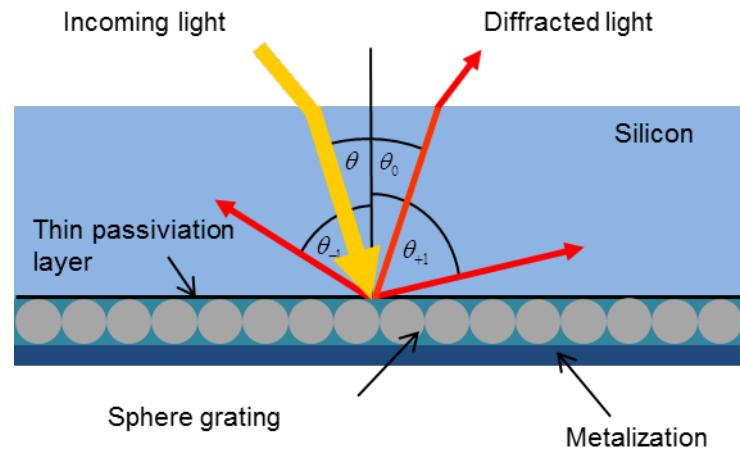
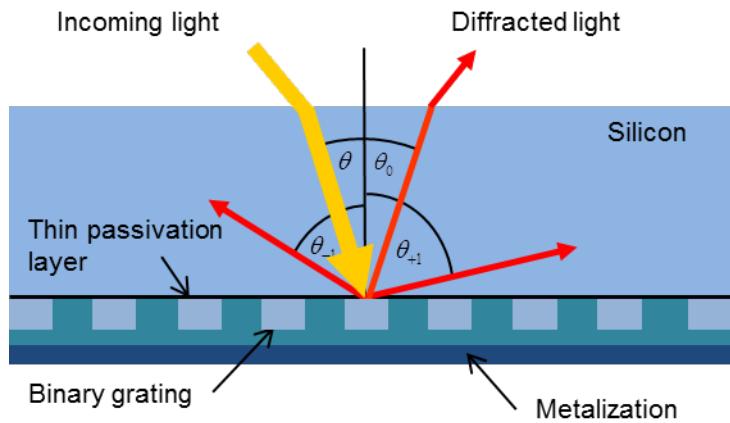


# Increasing Light Absorption Scattering Rear compares to Pyramid Front

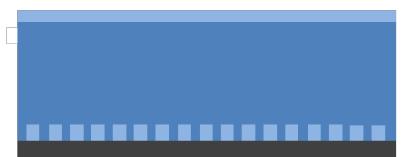
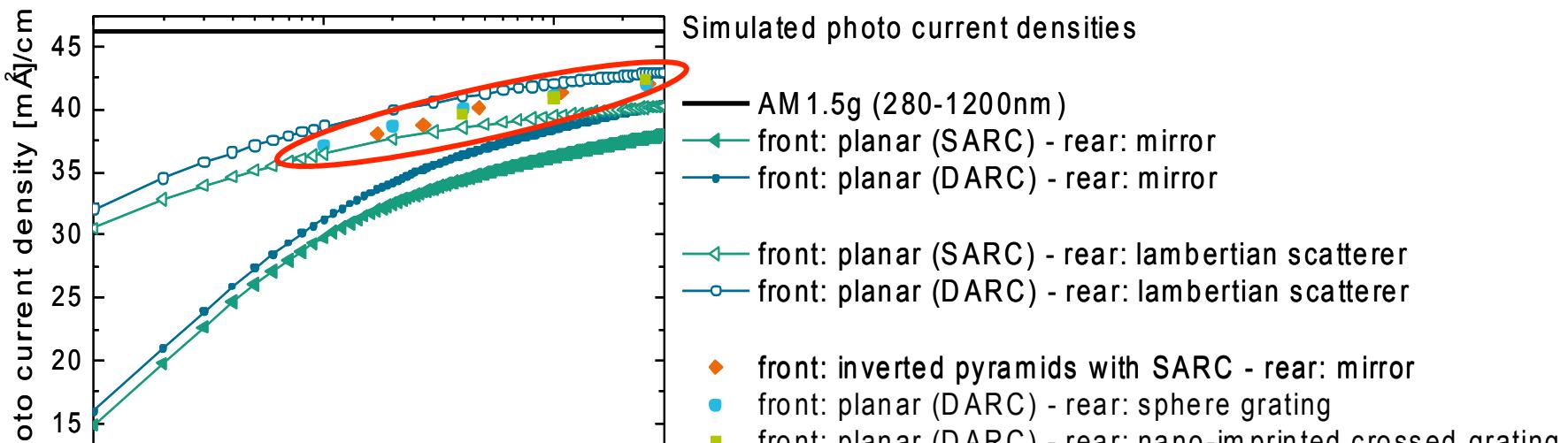


# Electrically flat and optically rough dielectric rear Hexagonal sphere gratings and nano-imprinted gratings

- Diffractive rear side structures: sphere gratings and nano-imprinted gratings
- Thin passivation layer separates silicon bulk and optical rear side structure

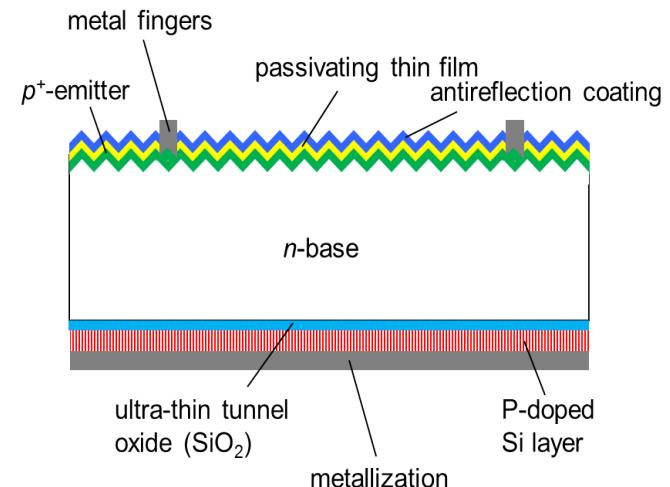


# Increasing Light Absorption Diffractive Rear Surfaces

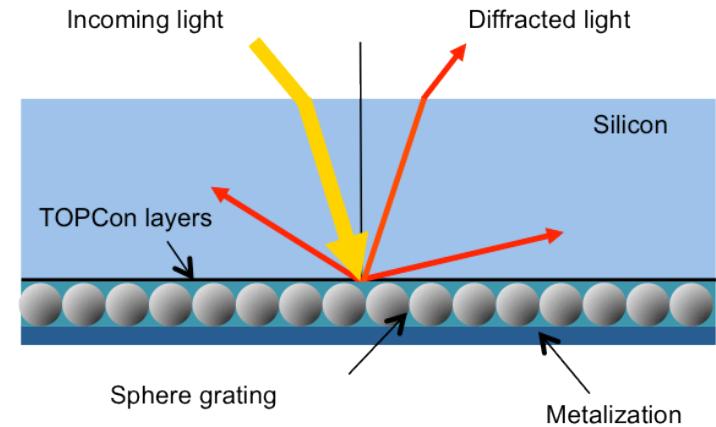


# Increased Light Absorption with Diffractive Rear Side Starting from Our Best Solar Cell

- Tunnel Oxide Passivated Contacts (TOPCon):  $\eta = 24.4\%$  demonstrated<sup>1</sup>



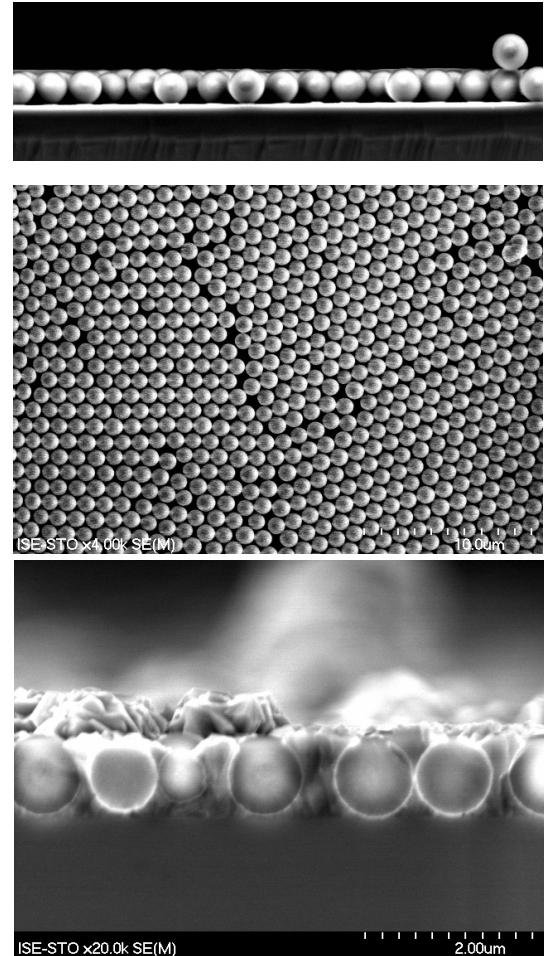
F. Feldmann et al., SOLMAT, Vol. 120, 2014, 270–274



<sup>1</sup> F. Feldmann et al., SOLMAT, *Tunnel oxide passivated contacts as an alternative to partial rear contacts*, Article in Press

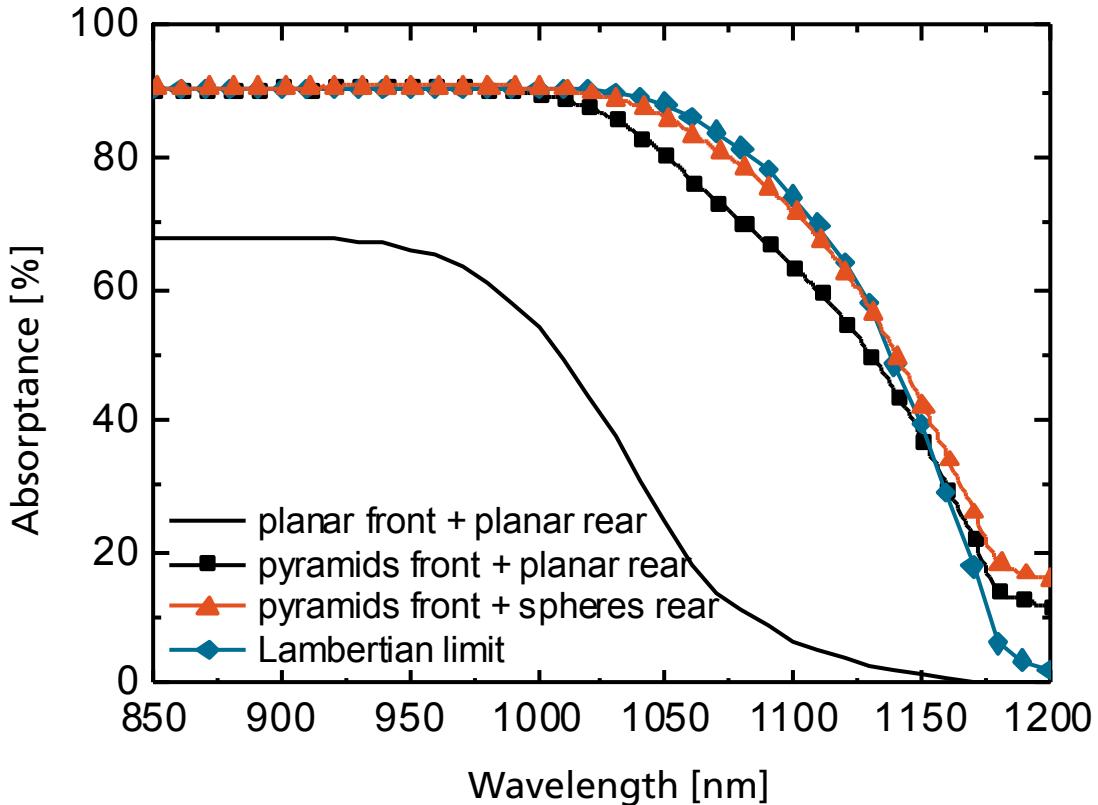
# Increased Light Absorption with Diffractive Rear Side Fabrication of Sphere Gratings

- Step 1: Spin coating of SiO<sub>2</sub>-spheres on TOPCon surface
- Step 2: Infiltration with silicon by APCVD-process
- Implied  $V_{oc} \approx 720 \text{ mV}$  after whole process chain (TOPCon + sphere grating + APCVD)



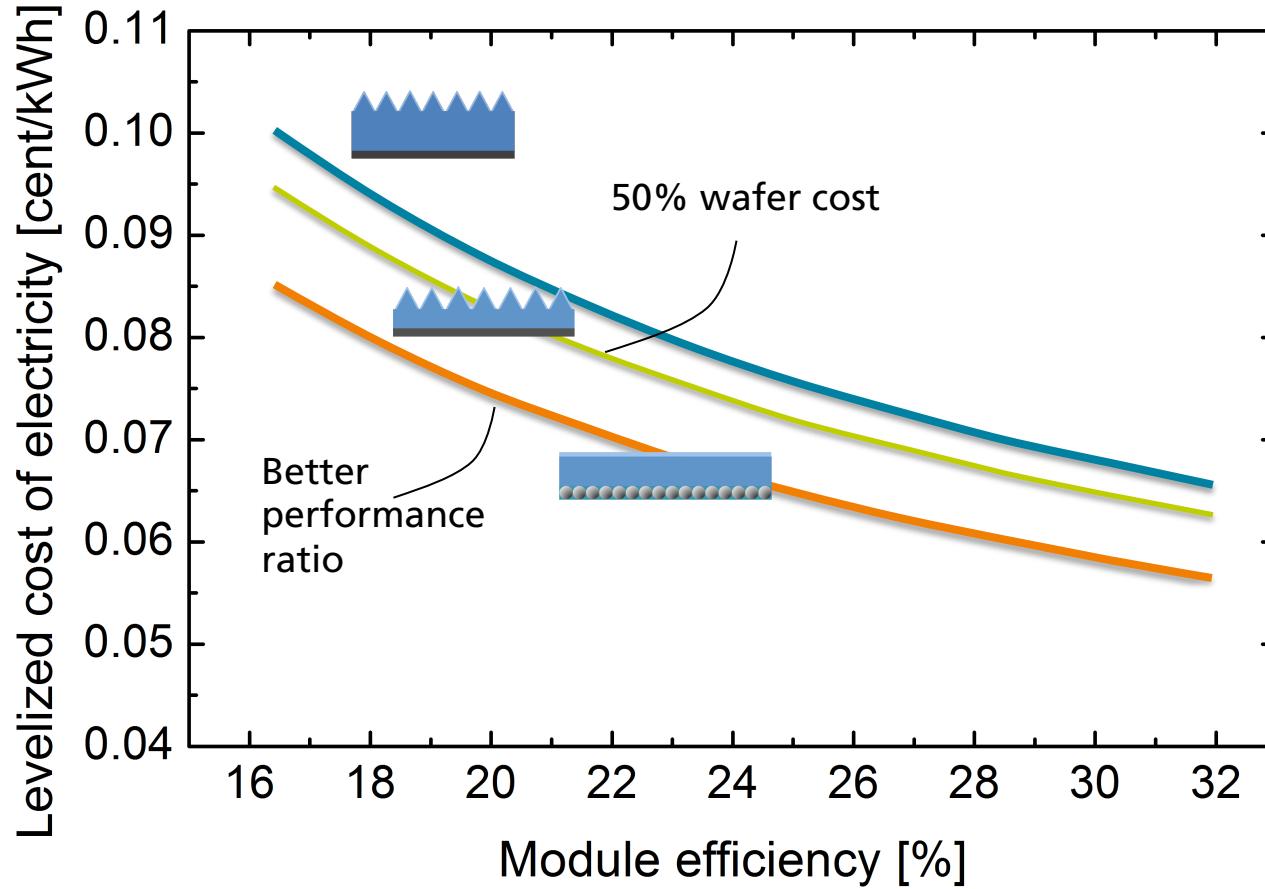
# Increased Light Absorption with Diffractive Rear Side Absorption Enhancement with Sphere Gratings

- Mirror behind all samples
- Sphere grating
- Absorption very close to Lambertian limit
- ~0.4 mA/cm<sup>2</sup> enhancement compared to front pyramids alone



# How Nanophotonics drive Competitiveness

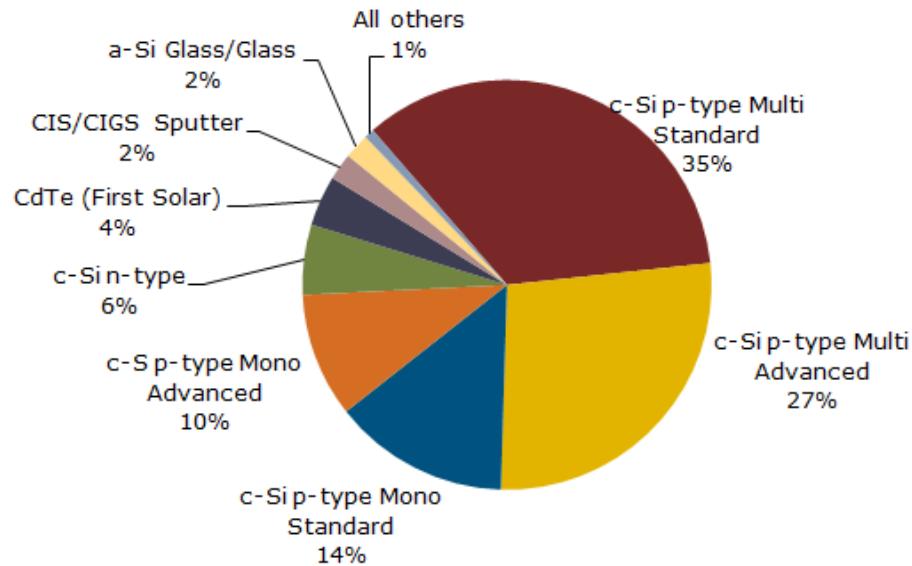
## Cost Calculations



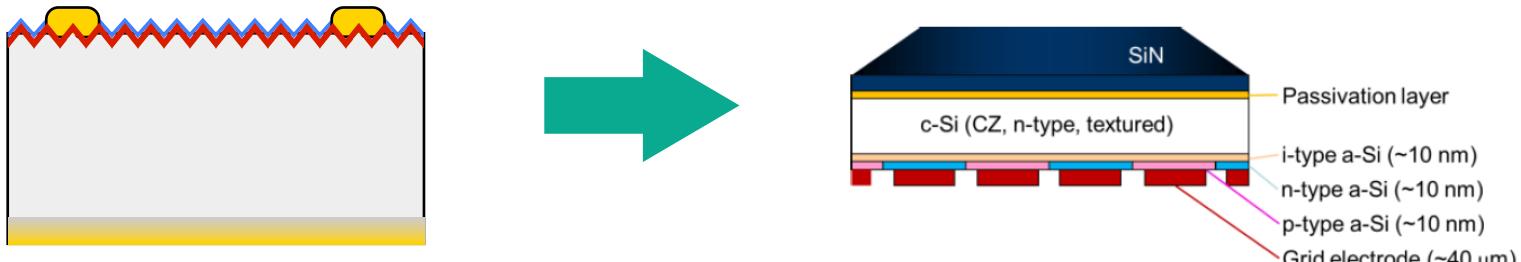
# Highly Efficient Solar Cells with Low Complexity

## State-of-the-Art Silicon Solar Cell

- Current reality in PV
- 91 % silicon
- **62 %** multi crystalline p-type silicon
  - > 90 % Al-BSF cells



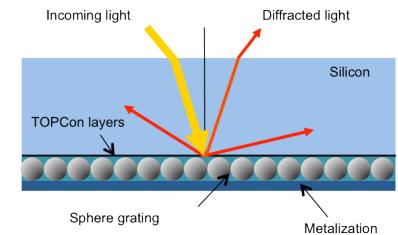
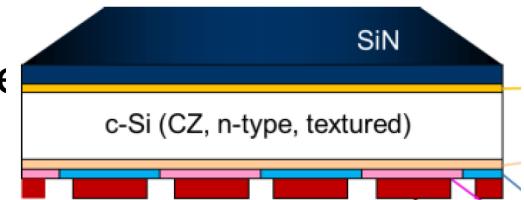
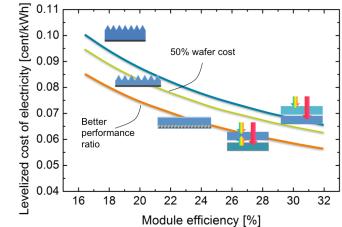
Will there be a transition to the more complex n-type BJBC with passivated contacts?



<http://www.solarbuzz.com/news/recent-findings/multicrystalline-silicon-modules-dominate-solar-pv-industry-2014>

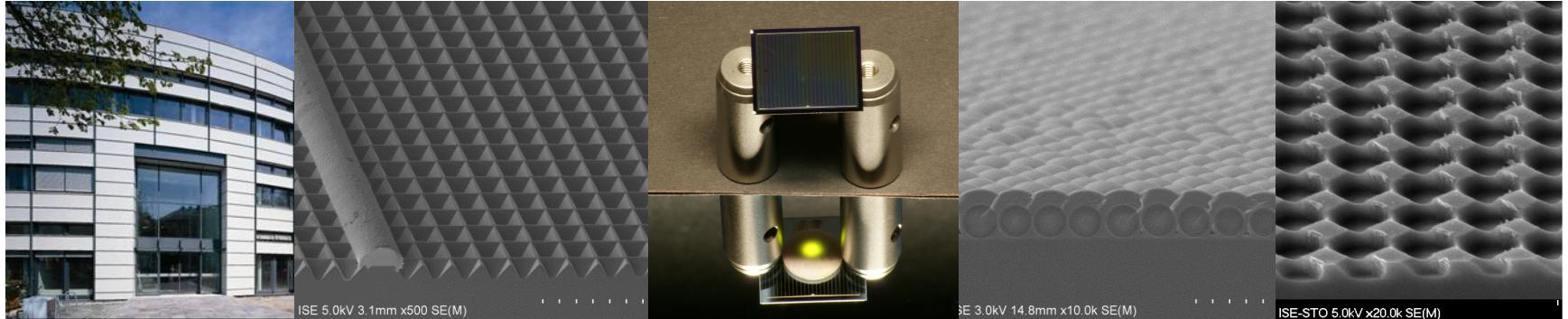
# Conclusion & Outlook

- Lower specific system costs main motivation for higher efficiencies
- Auger recombination limits efficiency to 29.4%
- General strategy for high efficiencies:  
Reduce optical, recombination and resistive losses
- Current world record of 25.6% is achieved with hetero-junction, inter-digitated back contact solar cells
- To be tackled next
  - Electrically thin, but optically thick solar cells with electrically flat, but optically rough surfaces
  - Highly efficient solar cells with low complexity



# Thank you for your attention!

and many colleagues at Fraunhofer ISE for input



## Fraunhofer-Institut für Solare Energiesysteme ISE

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